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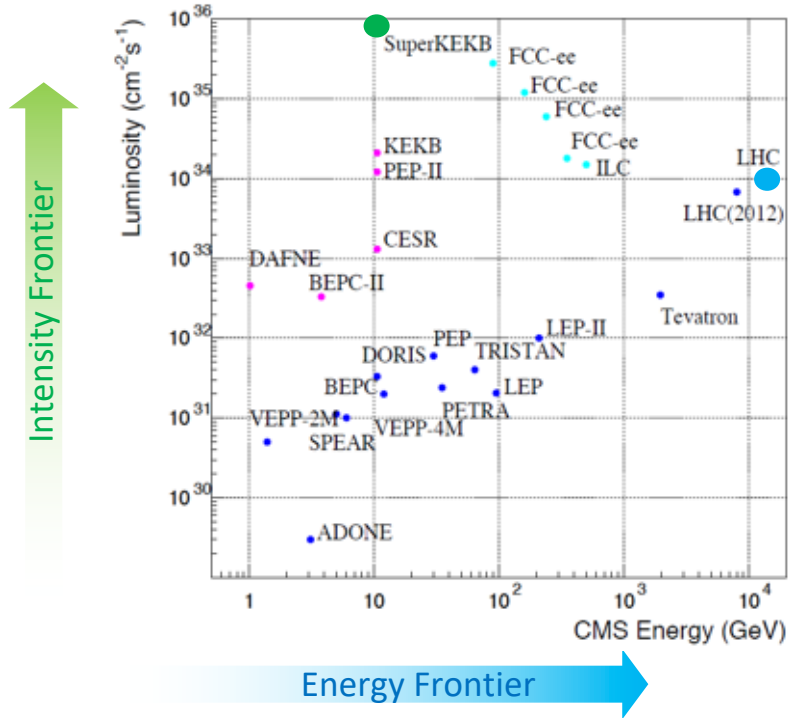
The Belle II Tracker Upgrade

C. Marinas
IFIC – Valencia

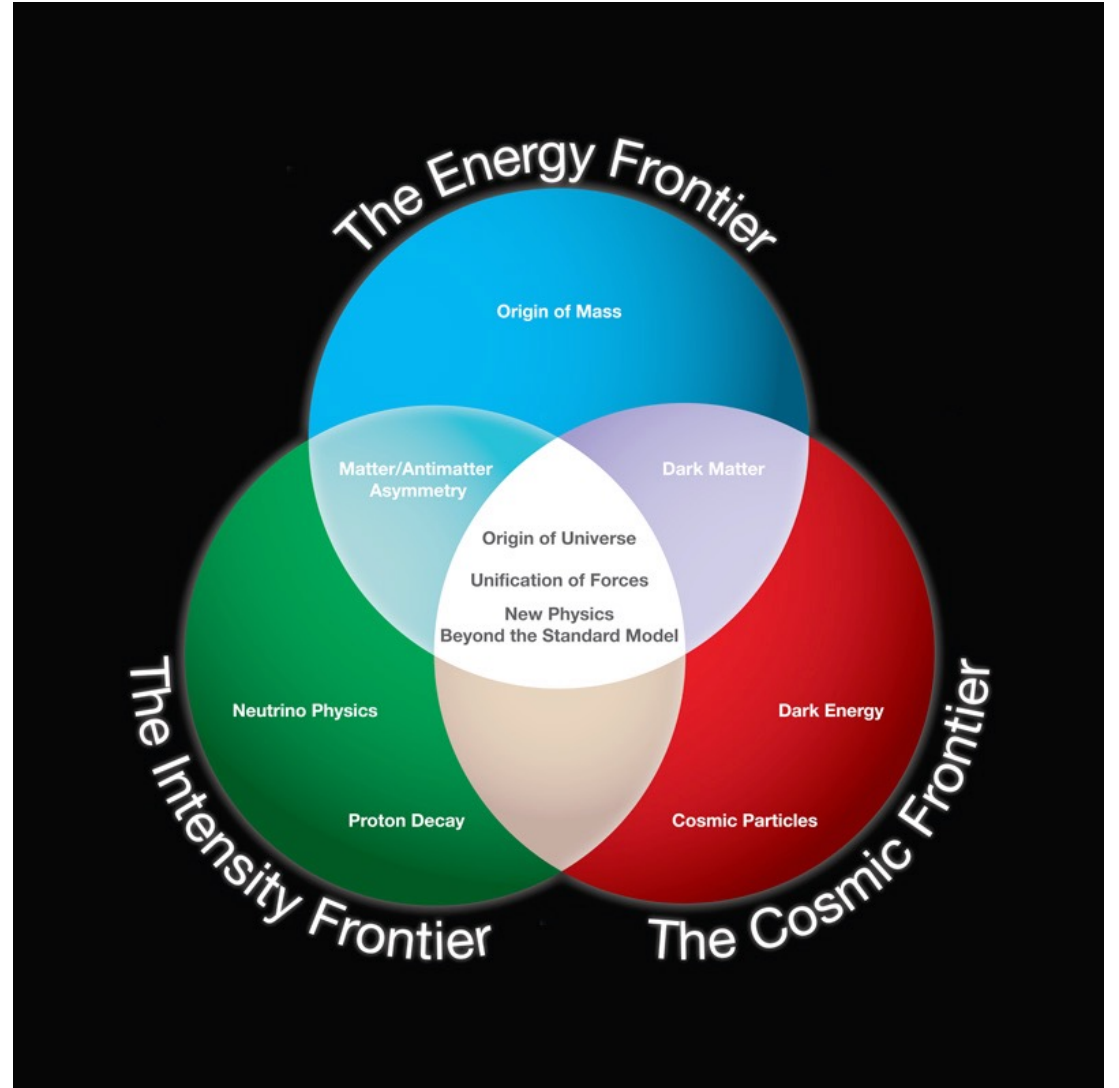
cmarinas@ific.uv.es



The Three Frontiers



- The **Intensity Frontier**: Search for rare new phenomena using *medium-energy high-luminosity* machines

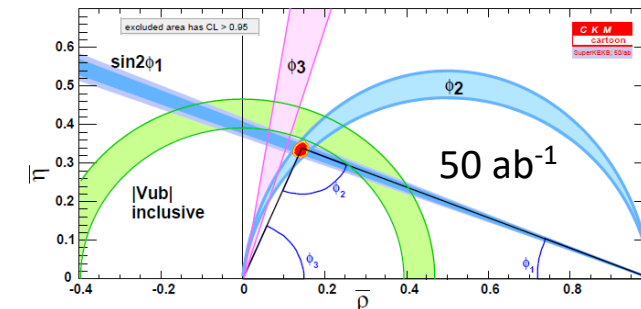
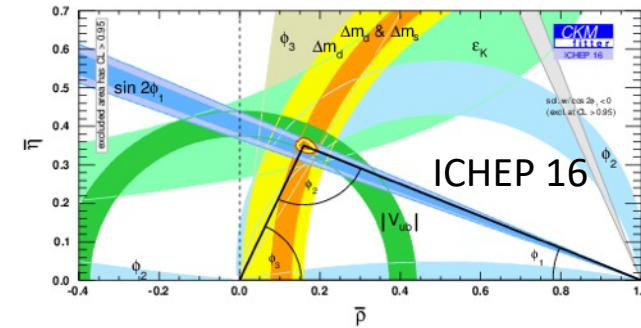


Super Flavor Factory

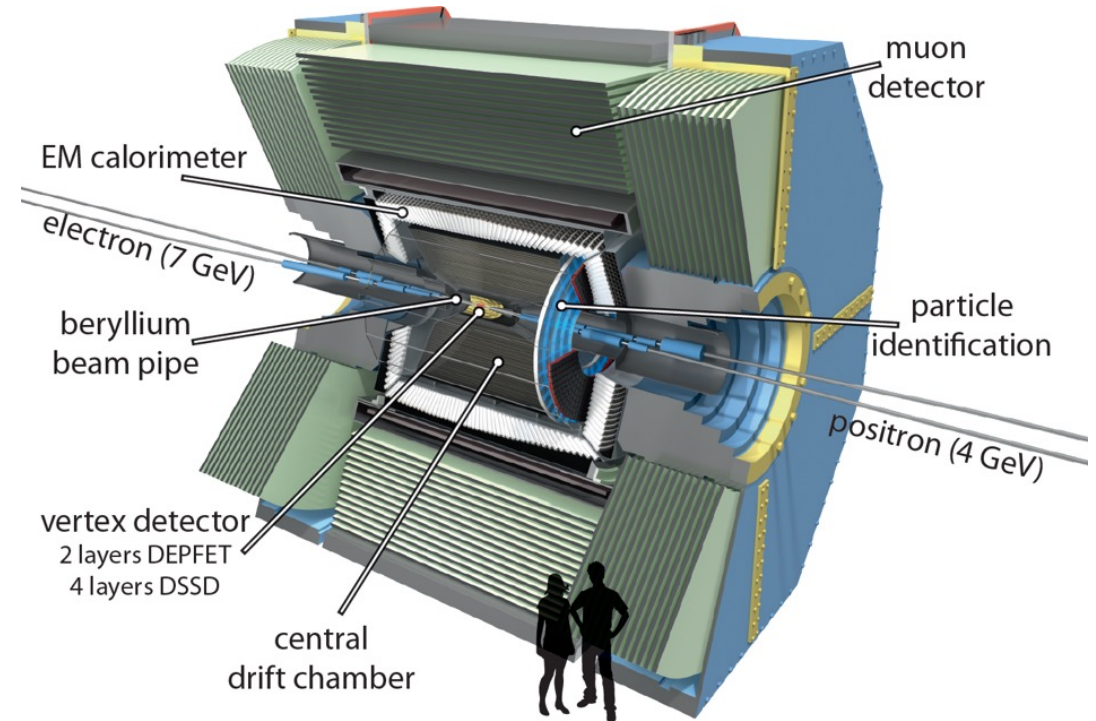
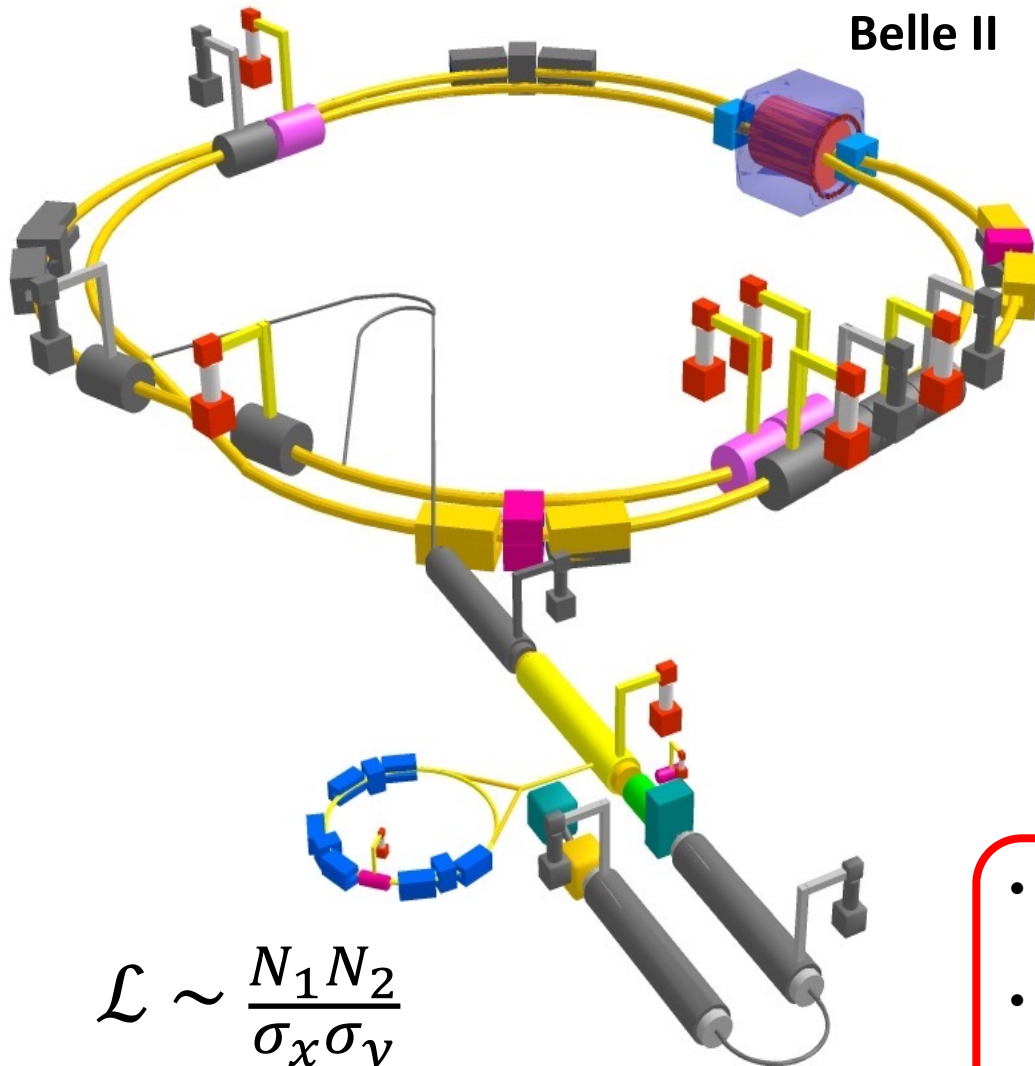
- Search for physics phenomena beyond SM in B, D and τ decays through precision measurements of the CKM sector and studies of rare or forbidden processes
- Many potential NP sources:
 - Flavor changing neutral currents
 - Lepton flavor violating decays
 - $B \rightarrow \tau$ tree level new physics
 - New sources of CPV

1. High luminosity accelerator
SuperKEKB
2. High-resolution and large-coverage detector
Belle II

Observable	SM theory	Current measurement (early 2013)	Belle II* (50 ab ⁻¹)
$S(B \rightarrow \phi K^0)$	0.68	0.56 ± 0.17	± 0.018
$S(B \rightarrow \eta' K^0)$	0.68	0.59 ± 0.07	± 0.011
α from $B \rightarrow \pi\pi, \rho\rho$		$\pm 5.4^\circ$	$\pm 1^\circ$
γ from $B \rightarrow DK$		$\pm 11^\circ$	$\pm 1.5^\circ$
$S(B \rightarrow K_S \pi^0 \gamma)$	< 0.05	-0.15 ± 0.20	± 0.035
$S(B \rightarrow \rho \gamma)$	< 0.05	-0.83 ± 0.65	± 0.07
$A_{CP}(B \rightarrow X_{s+d} \gamma)$	< 0.005	0.06 ± 0.06	± 0.005
A_{SL}^d	-5×10^{-4}	-0.0049 ± 0.0038	± 0.001
$\mathcal{B}(B \rightarrow \tau \nu)$	1.1×10^{-4}	$(1.64 \pm 0.34) \times 10^{-4}$	$\pm 3\%$
$\mathcal{B}(B \rightarrow \mu \nu)$	4.7×10^{-7}	$< 1.0 \times 10^{-6}$	$\geq 5\sigma$
$\mathcal{B}(B \rightarrow X_s \gamma)$	3.15×10^{-4}	$(3.55 \pm 0.26) \times 10^{-4}$	$\pm 6\%$
$\mathcal{B}(B \rightarrow K^{(*)} \nu \bar{\nu})$	3.6×10^{-6}	$< 1.3 \times 10^{-5}$	$\pm 30\%$
$\mathcal{B}(B \rightarrow X_s \ell^+ \ell^-) (1 < q^2 < 6 \text{ GeV}^2)$	1.6×10^{-6}	$(4.5 \pm 1.0) \times 10^{-6}$	$\pm 0.10 \times 10^{-6}$
$A_{FB}(B^0 \rightarrow K^{*0} \ell^+ \ell^-)$ zero crossing	7%	18%	5%
$ V_{ub} $ from $B \rightarrow \pi \ell^+ \nu$ ($q^2 > 16 \text{ GeV}^2$)	9% \rightarrow 2%	11%	2.1%



SuperKEKB and the Belle II Experiment



$$\mathcal{L} \sim \frac{N_1 N_2}{\sigma_x \sigma_y}$$

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- SuperKEKB: Asymmetric energy e^+e^- collider
 $E_{\text{cm}} = m(\Upsilon(4S)) = 10.58 \text{ GeV}$
- Peak luminosity: $\mathcal{L} = 6 \cdot 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$ (x40 than KEKB)
Beam size reduction. Higher current (x2 higher).

The SuperKEKB Accelerator

Mt. Tsukuba

SuperKEKB ring (HER+LER)

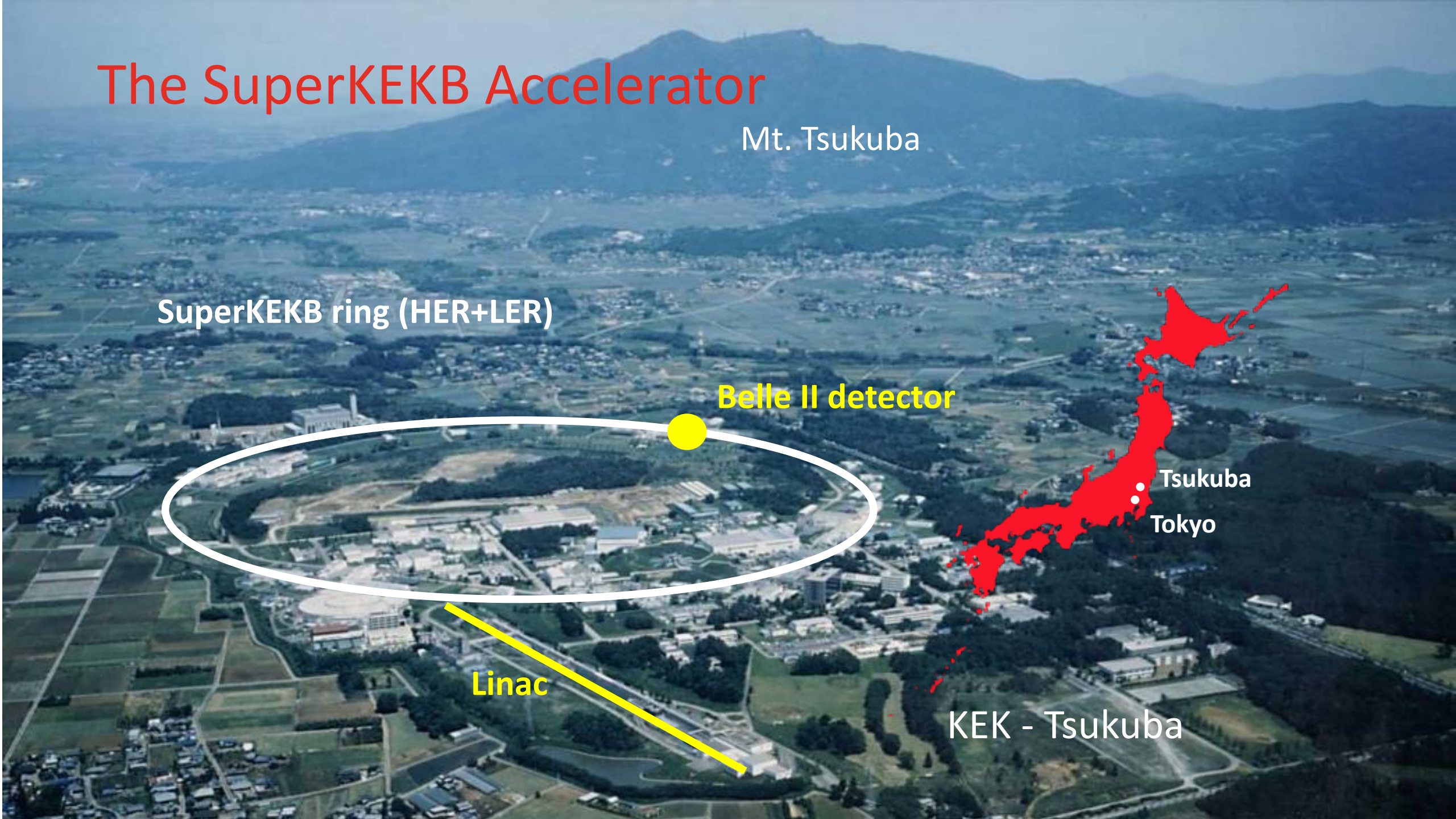
Belle II detector

Linac

Tsukuba

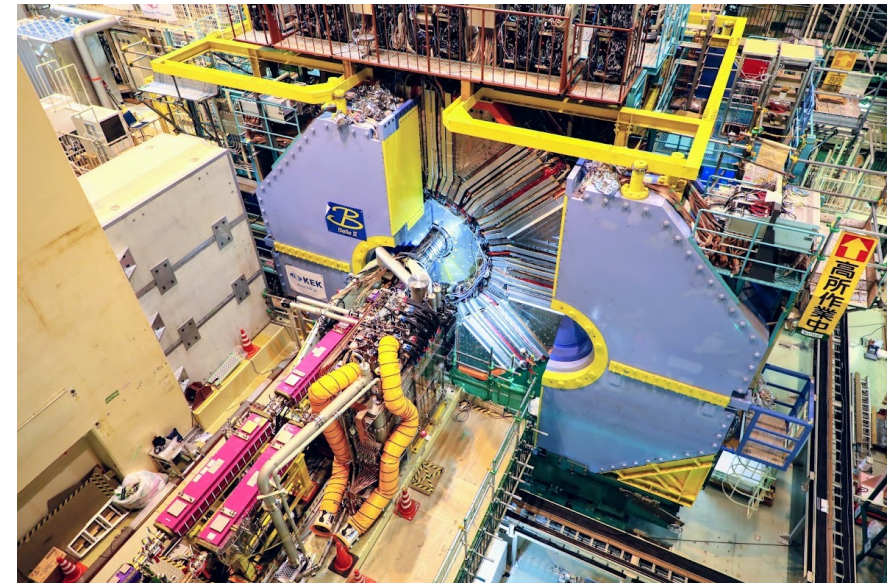
Tokyo

KEK - Tsukuba

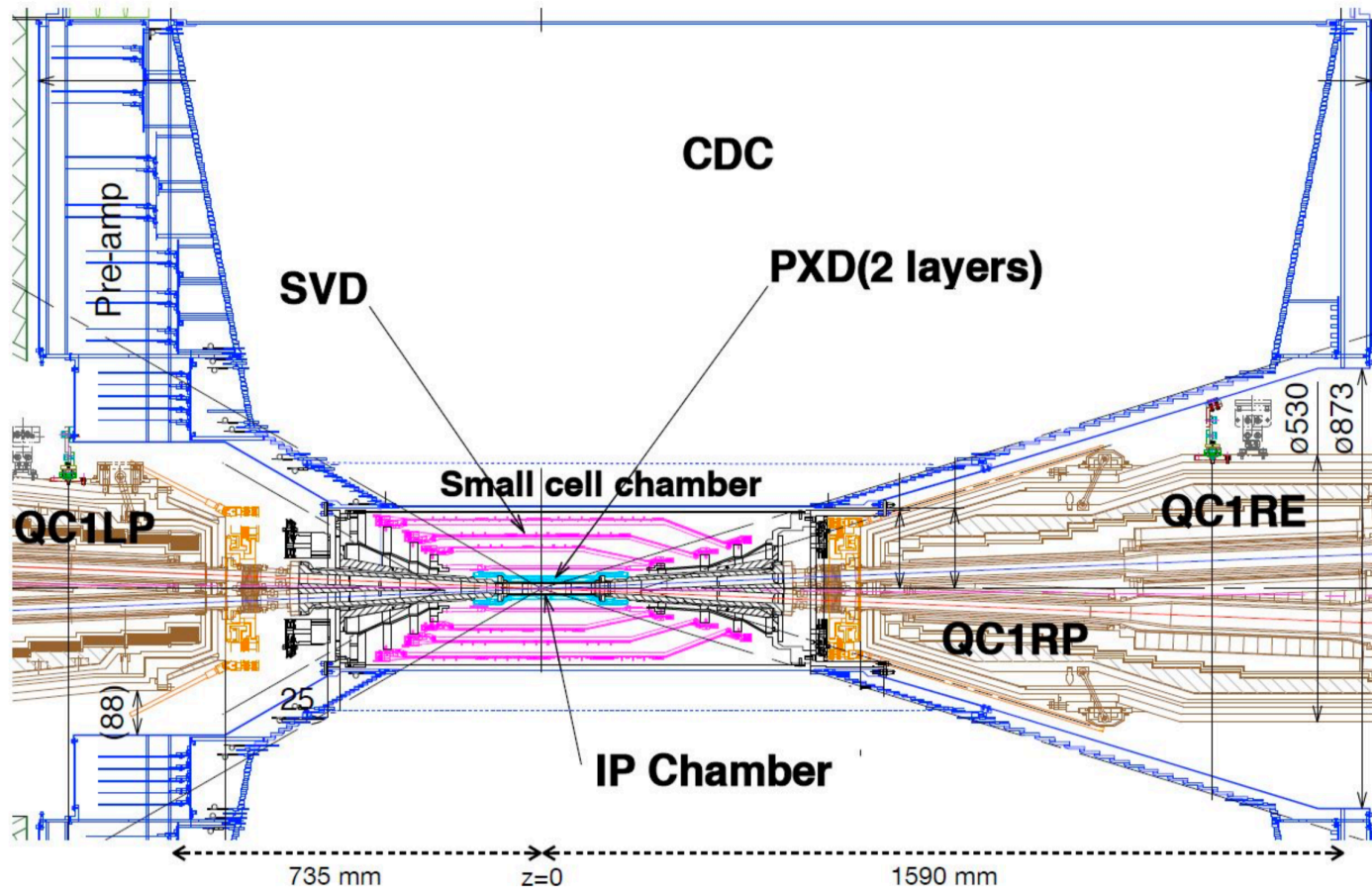


The Belle II Collaboration

- 27 countries
- 132 institutions
- 1175 members



Belle II Tracking System

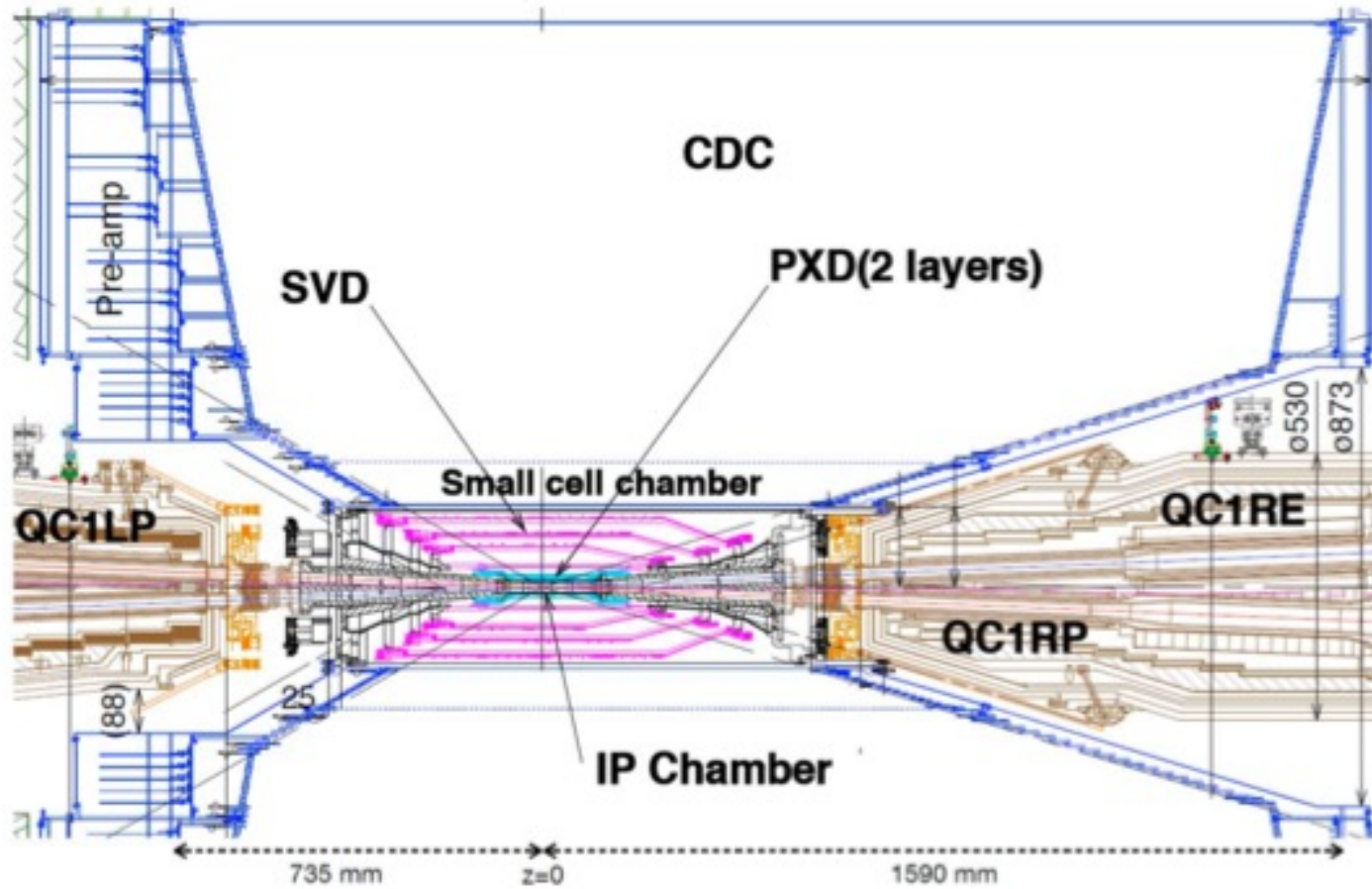


Three tracking sub-systems:

- Pixel Detector (PXD)
- Silicon Vertex Detector (SVD)
- Central Drift Chamber (CDC)

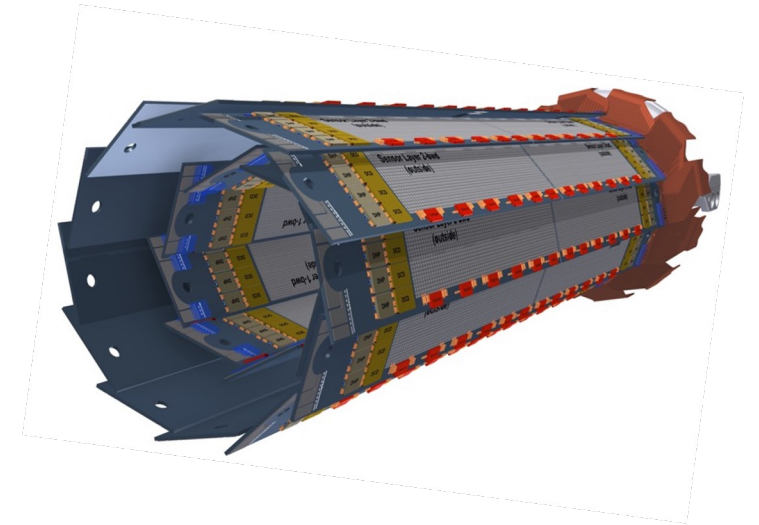
1.5 T solenoid and final focusing magnets inside detector volume

Belle II Tracking System

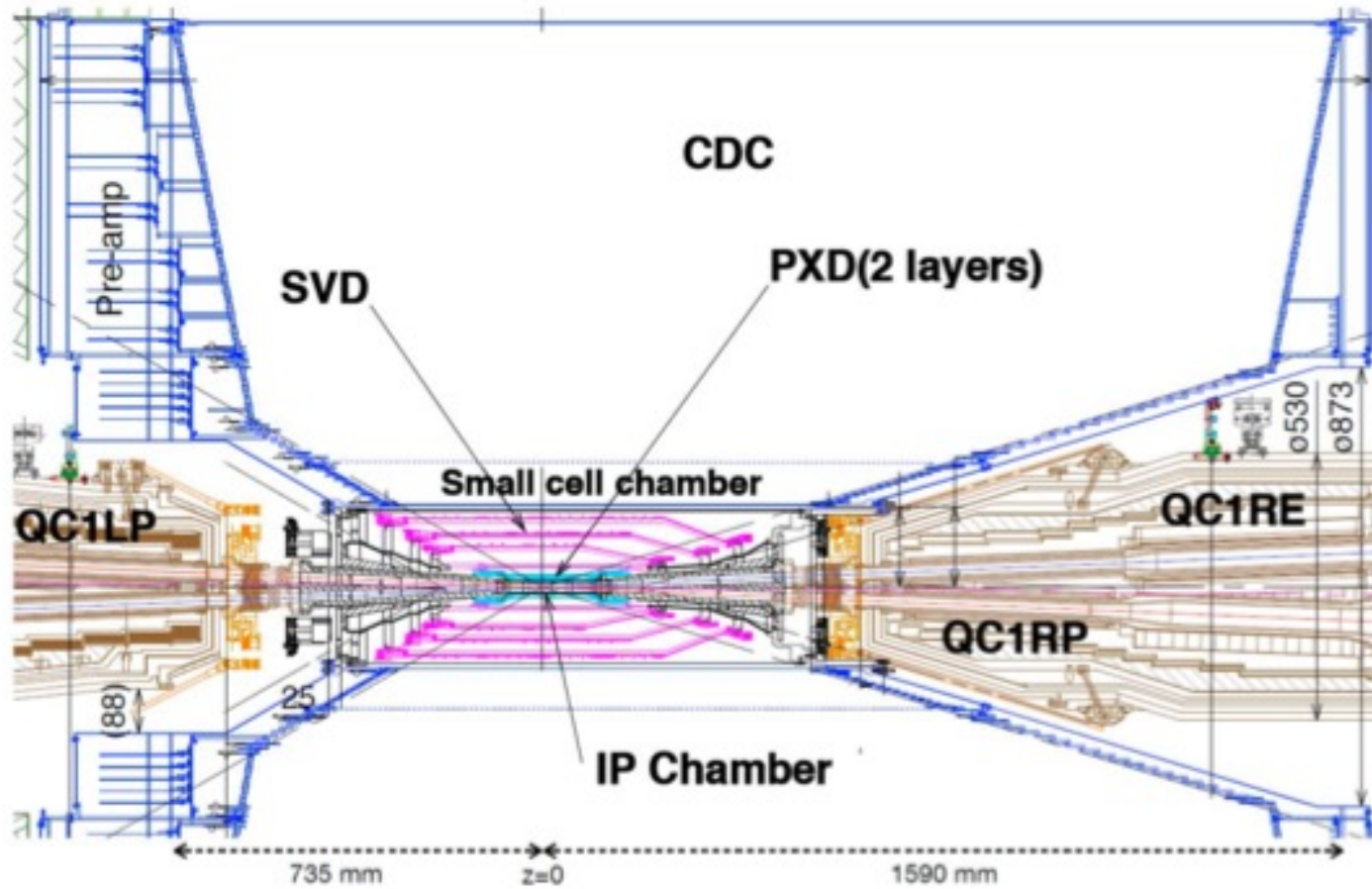


- PXD

2 layers of DEPFET pixels
 $r = 1.4 \text{ cm}, 2.2 \text{ cm}$
 $L = 12 \text{ cm}$
 $\sim 0.027 \text{ m}^2$



Belle II Tracking System

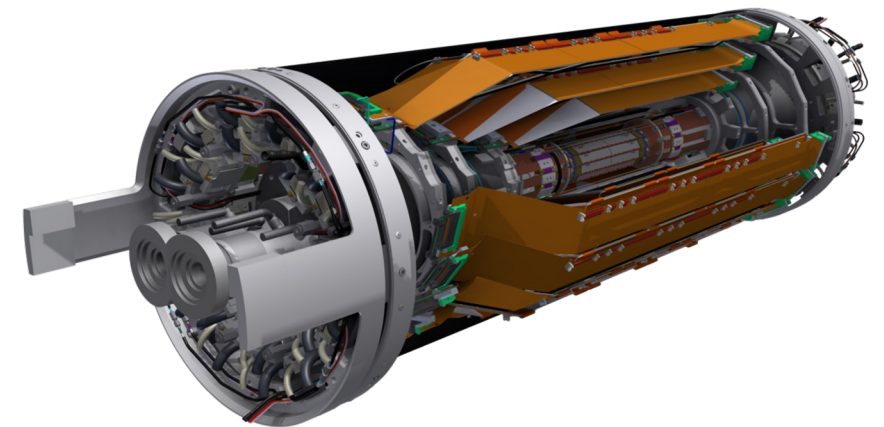


- SVD

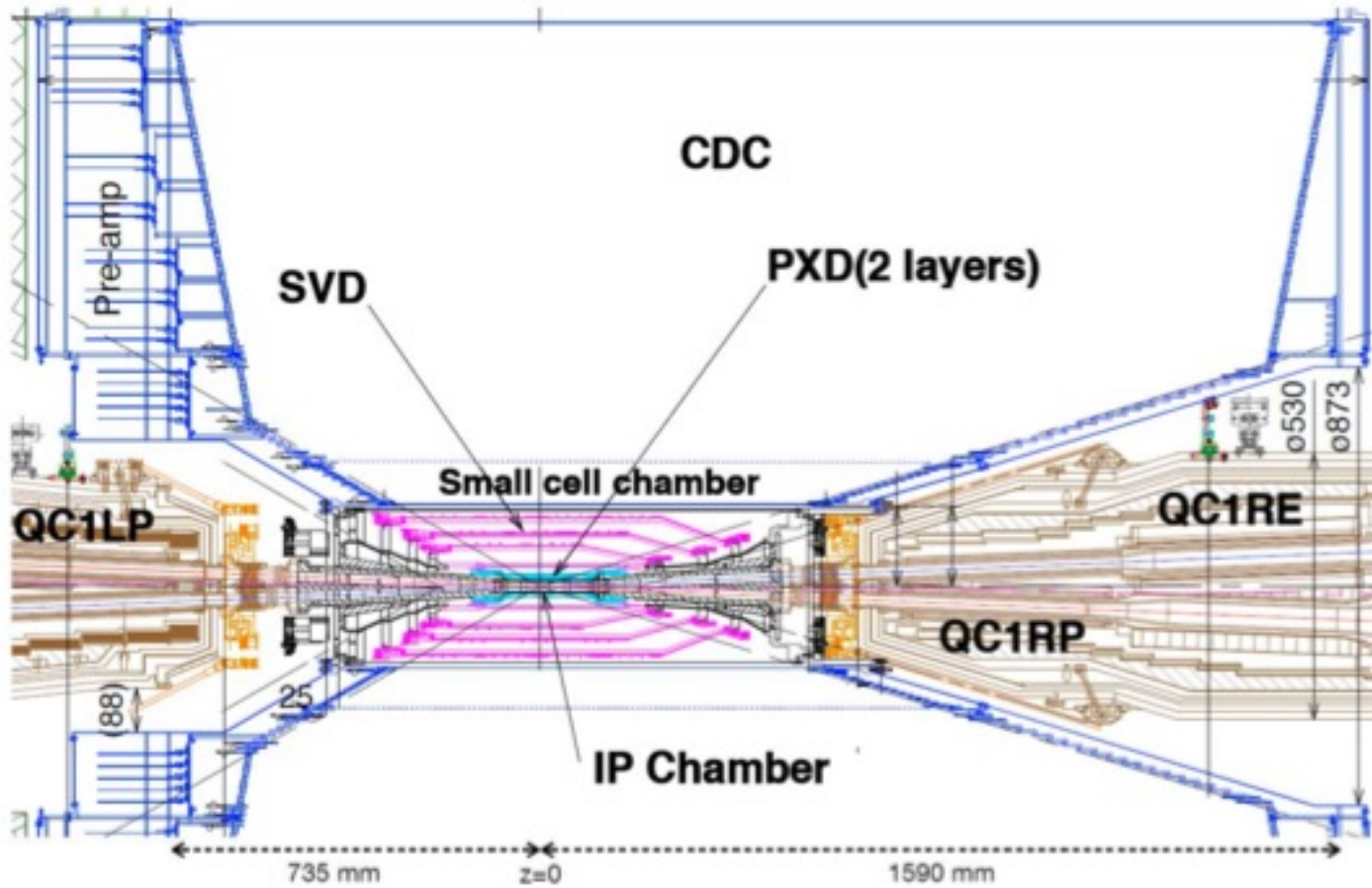
4 layers of DSSD ($r = 39 - 135$ mm)

$L = 60$ cm

~ 1 m²

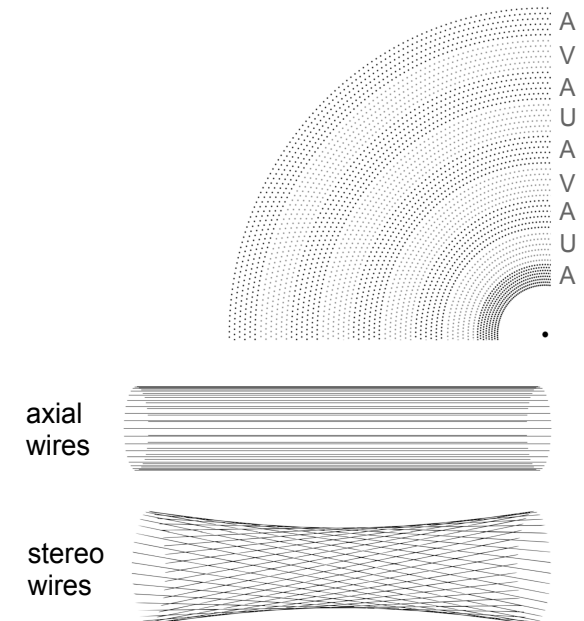


Belle II Tracking System



- CDC

56 layers ($r = 168 - 1111$ mm)
Arranged into superlayers of axial (A)
and stereo (U, V) wires



First Collisions (26 April 2018)

First collisions at Belle II

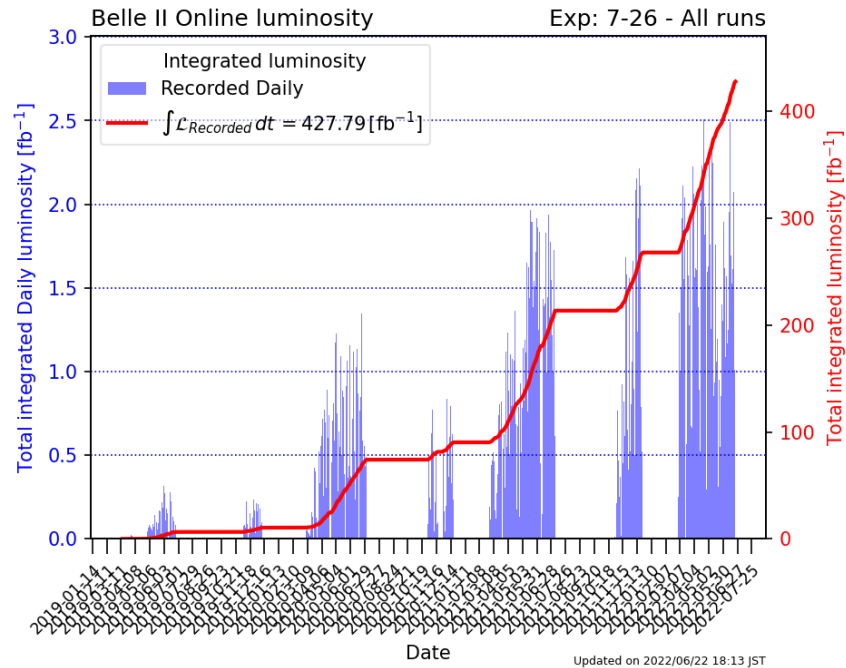
04/25/18 | By Sarah Lawhun

The Japan-based experiment is one step closer to answering mystifying questions about antimatter.

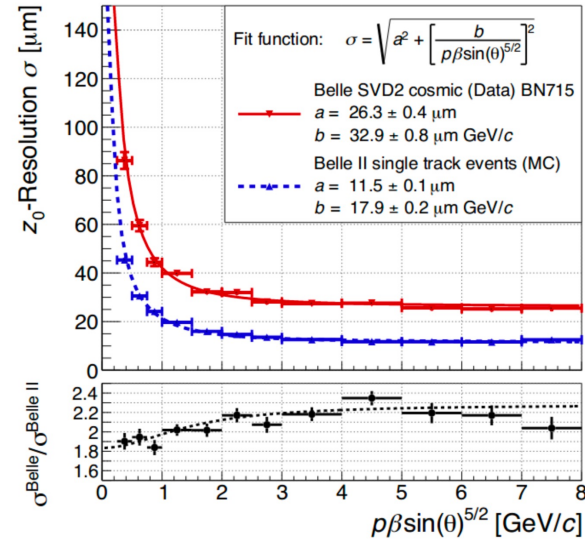


KEK/Belle II

Current Status – Performance Benchmarks



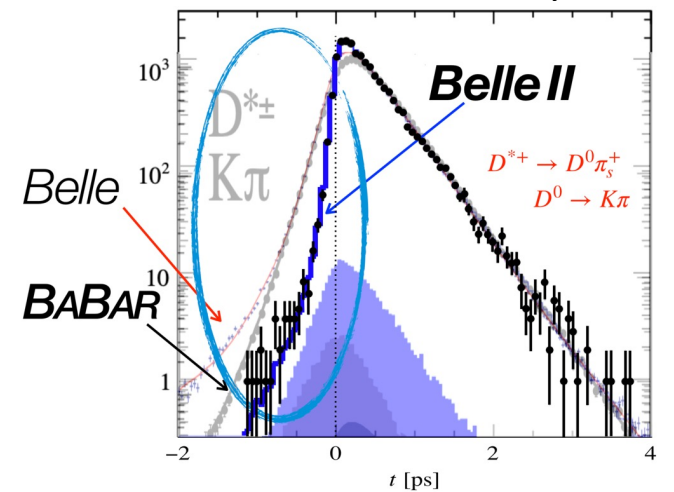
- $L_{\text{peak}} = 4.7 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$ (x2 KEKB)
- $L_{\text{integrated}} = 430 \text{ fb}^{-1}$ (\sim BaBar)
- Data taking efficiency $>90\%$
- Precision measurements



Decay time resolution x2 better than Belle and BaBar

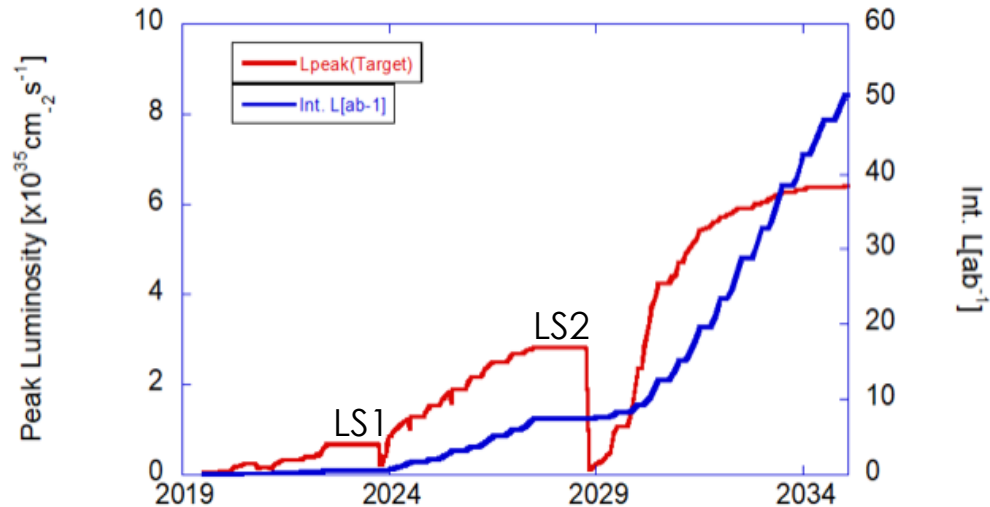
Excellent tracking performance (2x better single vertex resolution wrt Belle)

World's best D lifetime measurement with only 72 fb^{-1}



Important test of Belle II tracking performance
 \rightarrow VXD reconstruction, track finding and vertex fitting

Belle II Upgrade Program



LS1: Actual detector consolidation
LS2: IR and detector upgrades

→ Currently: CDR preparation

Submitted to the Proceedings of the US Community Study
on the Future of Particle Physics (Snowmass 2021)

Snowmass Whitepaper: The Belle II Detector Upgrade Program

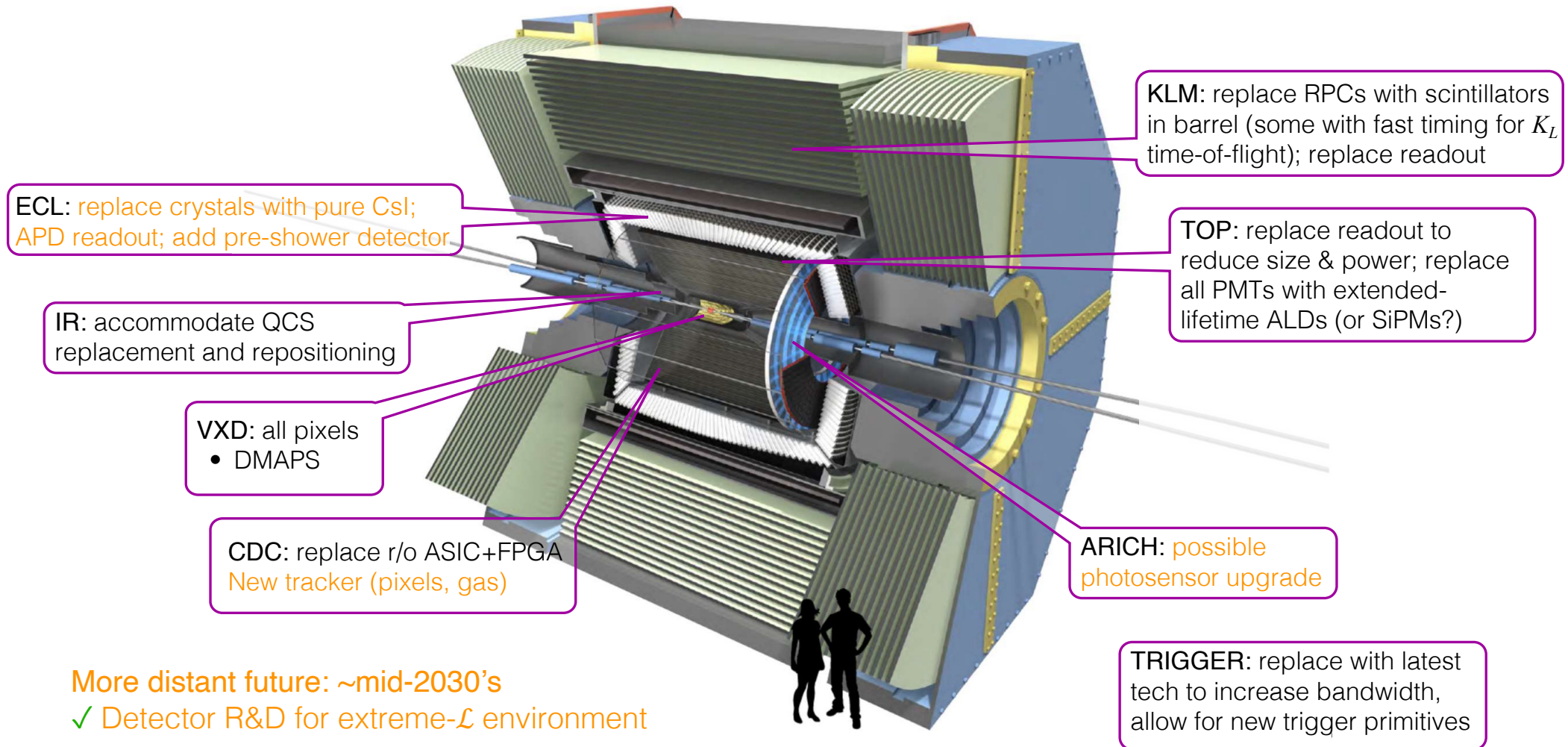
Belle II Collaboration

March 23, 2022

Abstract

We describe the planned near-term and potential longer-term upgrades of the Belle II detector at the SuperKEKB electron-positron collider in Tsukuba, Japan. These upgrades will allow increasingly sensitive searches for possible new physics beyond the Standard Model in flavor, tau, electroweak and dark sector physics that are both complementary to and competitive with the LHC and other experiments. We encourage the instrumentation-frontier community to contribute and study upgrade ideas as part of the Snowmass process.

Belle II Upgrade Program



Requirements for VXD Upgrade

Upgrade motivation:

- Cope with larger background activity
- Improve momentum and impact parameter resolution in low p_T region
- Simplify tracking chain with all layers involved
- Operation without special modes nor data reduction

Key sensor specifications:

- Pixel pitch 30-40 μm
- Integration time $\lesssim 100$ ns
- Power dissipation $\lesssim 200$ mW/cm²

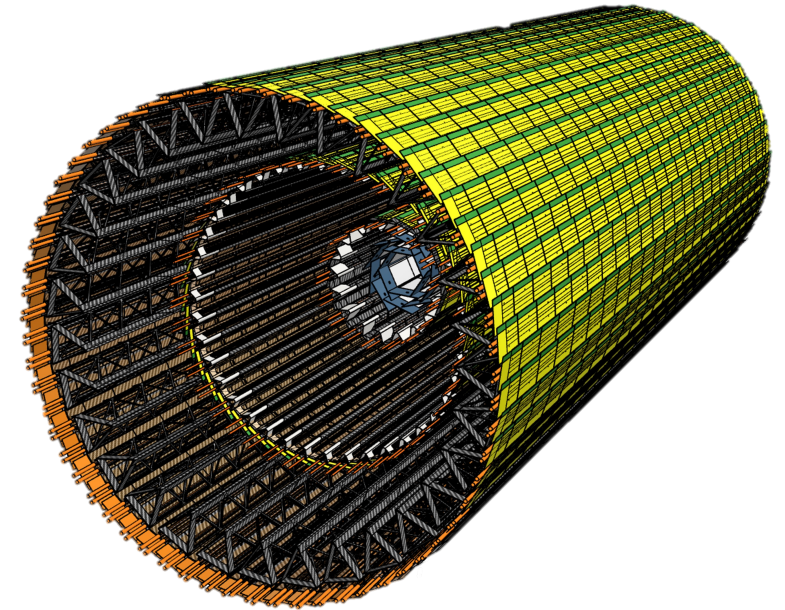
Improve physics reach per ab^{-1}

Radius range	14 – 135 mm
Tracking & Vertexing performance	
Single point resolution	$< 15 \mu\text{m}$
Material budget	0.2% X_0 / 0.7% X_0 inner- / outer- layer
Robustness against high radiation environment (innermost layer)	
Hit rate	~ 120 MHz/cm ²
Total ionizing dose	~ 10 Mrad/year
NIEL fluence	$\sim 5e13$ n _{eq} /cm ² /year

Belle II Upgrade: VTX - DMAPS

SuperKEKB and Belle II LS2 Upgrade

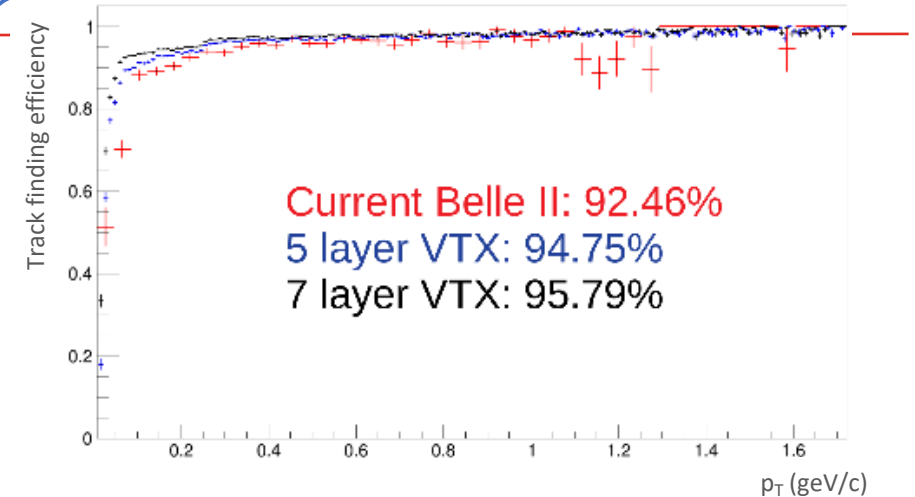
- 5 straight layers barrel, using CMOS pixel sensors
- Low material : 0.1% X_0 (L1+L2) - 0.4% (L3) - 0.8% X_0 (L4+L5)
- Moderate pixel pitch $\sim 30 \mu\text{m}^2$
- Fast integration time 50-100 ns
- iVTX: innermost 2 layers, self-supported, air cooled
- oVTX: 3 outer layers, CF structure, water cooled
- Overall service reduction and operation simplification



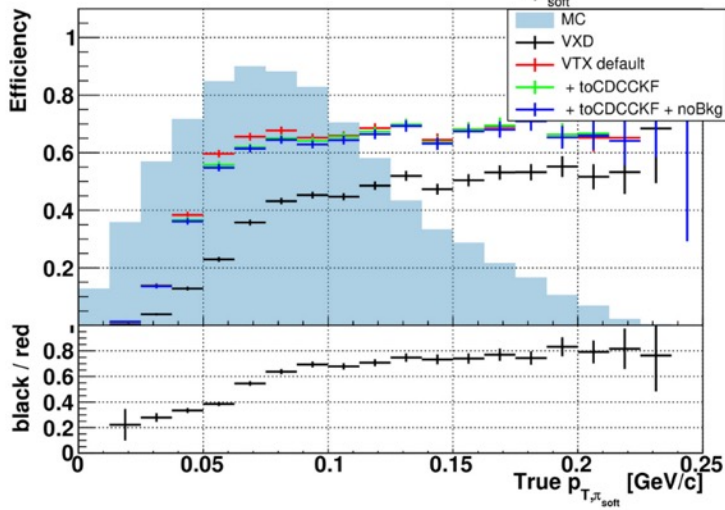
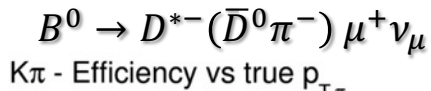
Performance Studies

- Full simulation in Belle II analysis software
 - 5 layer geometry implemented
 - Detailed digitizer model tuned from test beam data
 - Tracking algorithms re-trained
 - Estimated backgrounds at $8 \times 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$

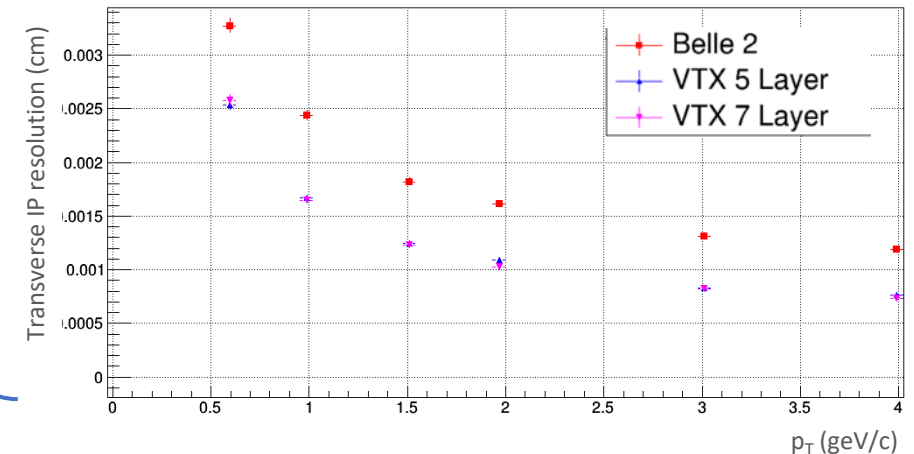
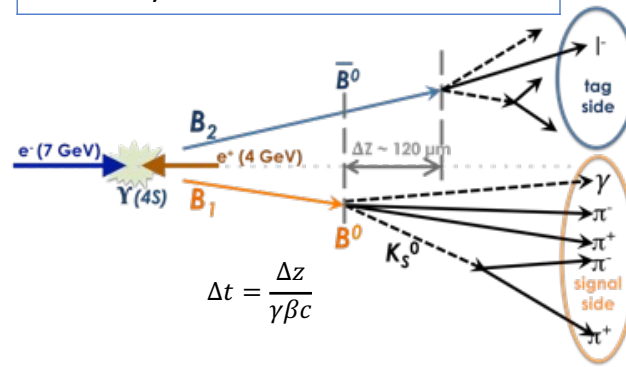
Tracking



Physics Benchmarks

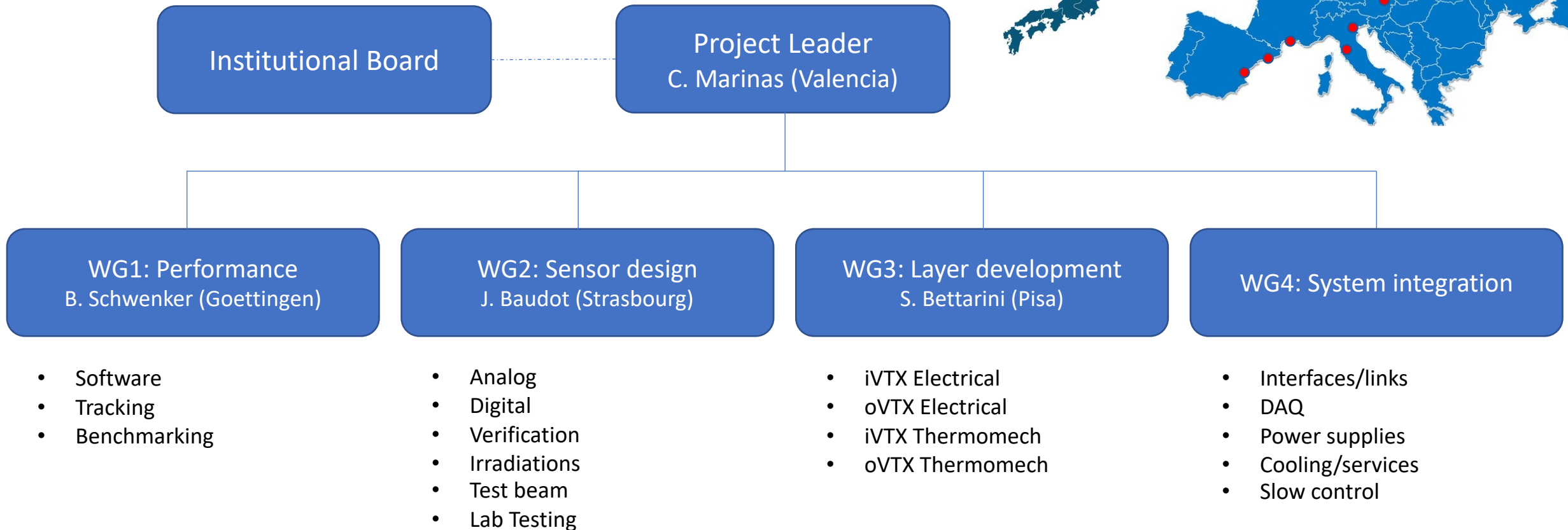


Geometry	Δt Resolution (ps)
VXD	1.12 ± 0.11
VTX 5 layers	0.82 ± 0.02

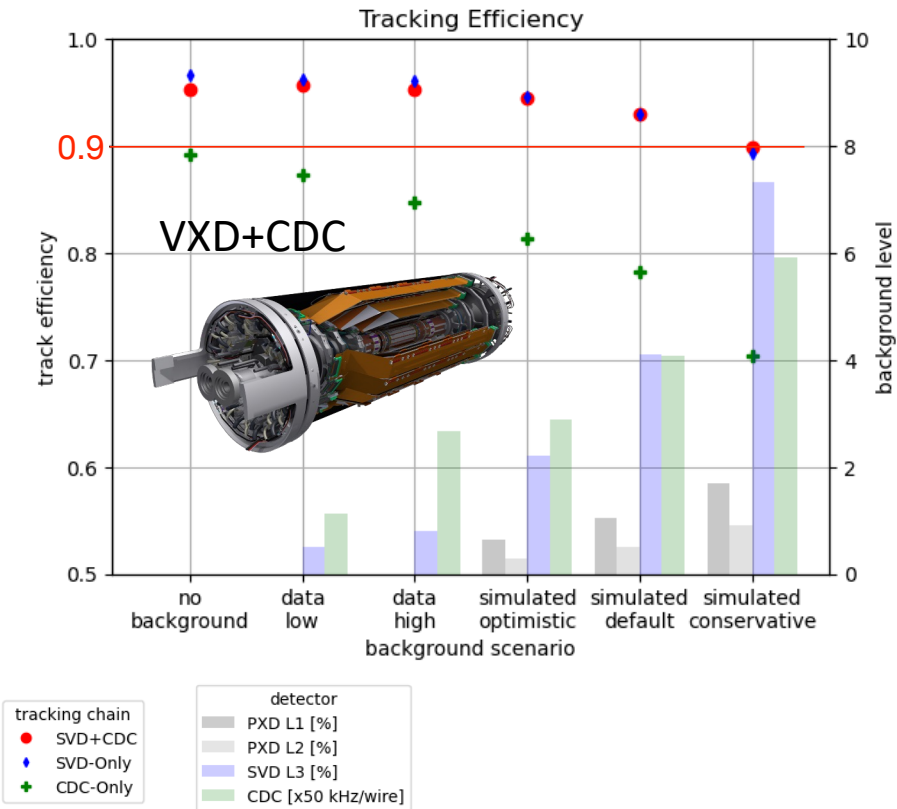


→ VTX performs slightly better / current VXD

Belle II VTX - Organization



Tracking Efficiency under High Backgrounds

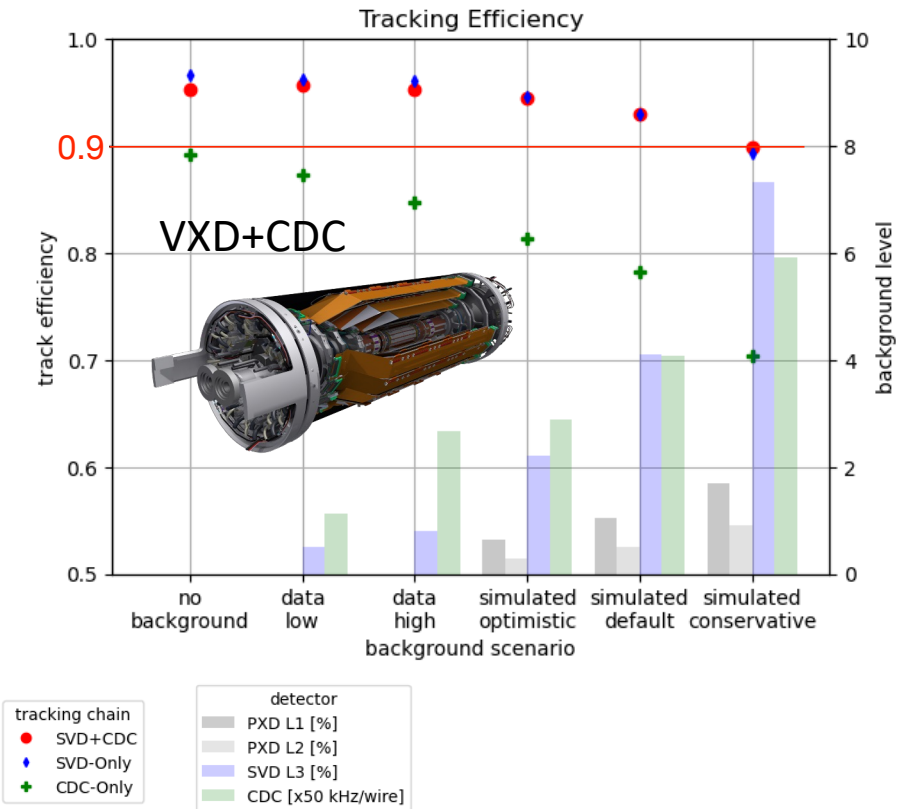


Tracking efficiency reaching 90% with current configuration with:

SVD at 7% occupancy

CDC at 300 kHz/wire hit rate

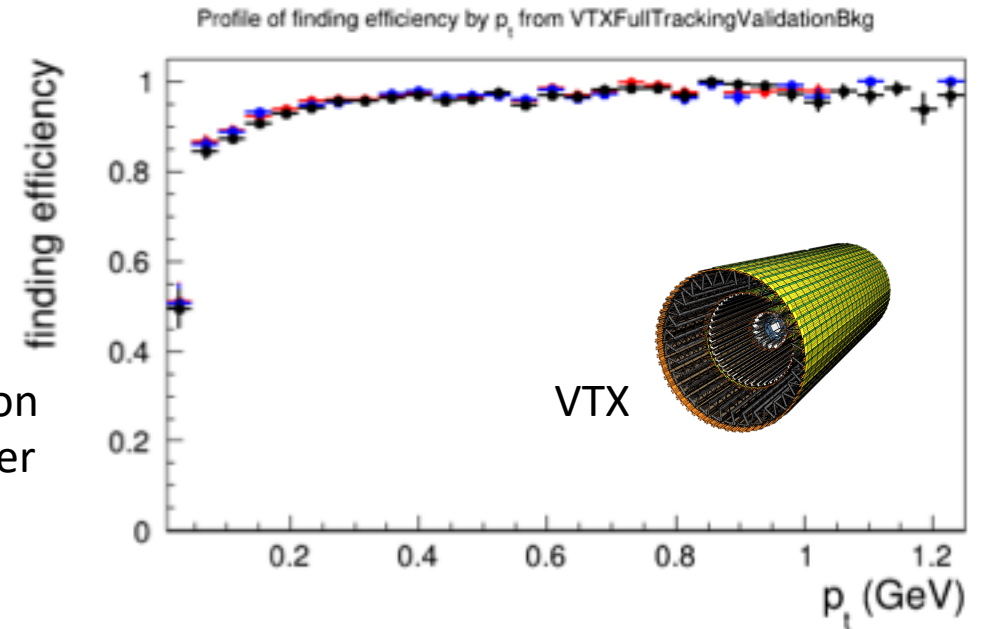
Tracking Efficiency under High Backgrounds



Tracking efficiency reaching 90% with current configuration with:

SVD at 7% occupancy

CDC at 300 kHz/wire hit rate



With new VTX: All-silicon tracking with x200 lower occupancy

→ VTX will take over CDC tracking at large background conditions

DMAPS for Belle II – LS2 and Beyond

Starting prospective ideas on simulation beyond VTX

- **Main tracker upgrade**

Replace totally/partially the CDC with DMAPS

Pitch 30-50 μm

1 ns time-stamping with TRG capability

50 mW/cm^2 power budget

1 MHz/cm^2 hit-rate

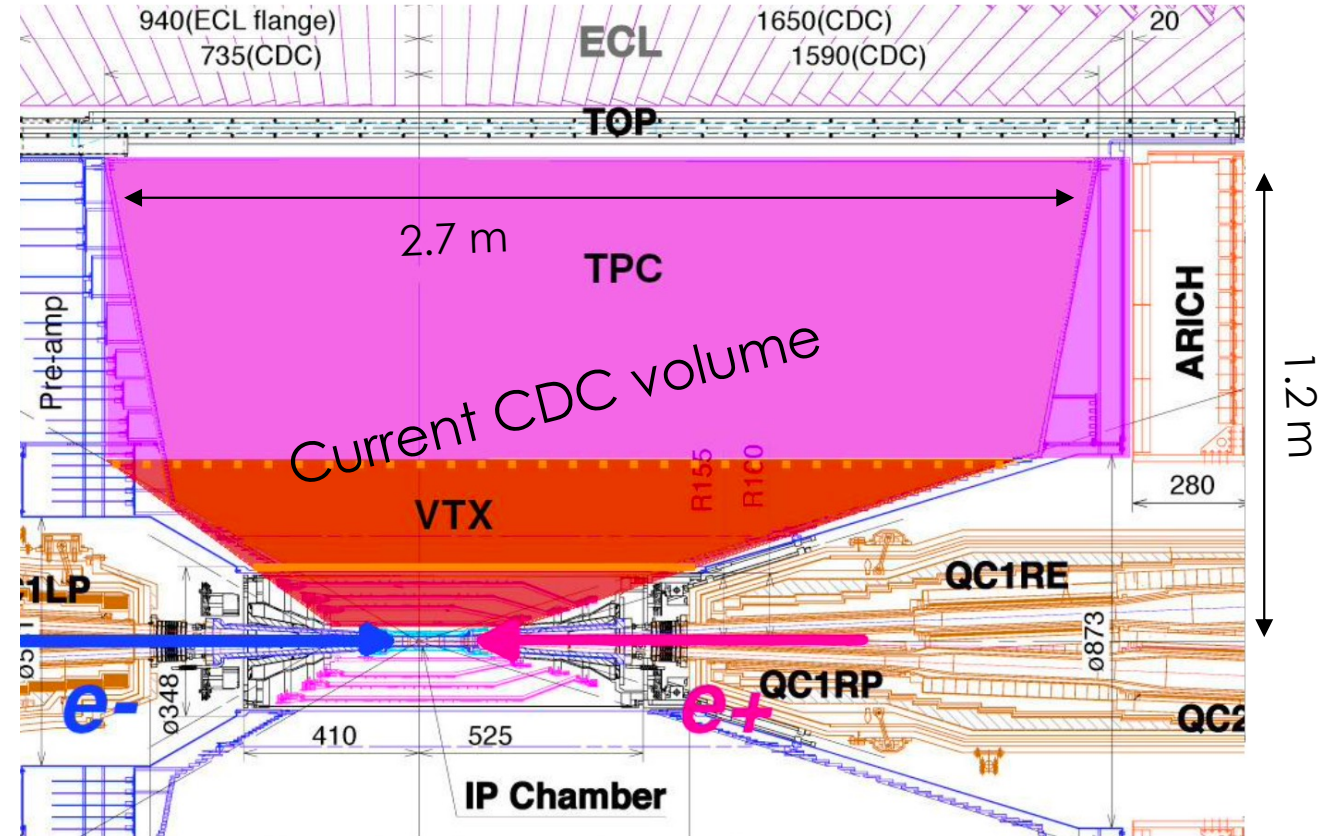
Low radiation hardness

- **Timing layers**

Trigger and PID (DMAPS?)

Time resolution 10-100 ps

Pad-like pixels



→ Large synergies with ECFA roadmap requirements

Belle II Vertex and Tracker: European Strategic Project

- Belle II upgrade identified as a strategic project on flavor collider experiments

Different environmental constraints	Strategic Projects	Tracking Vertex Detector (VD) Central Tracker (CT)	Timing Layer (TL) + Calorimeter
	Heavy Ion	ALICE-3, EIC	ALICE-3 (LS4+), EIC
	Flavour collider	BELLE-3	BELLE-3
	Lepton collider	ILC, CLIC FCCee, Muon Collider	ILC, CLIC FCCee, Muon Collider
	pp collider	LHCb-2, ATLAS, CMS FCC-hh	LHCb-2, ATLAS, CMS FCC-hh

DRD3 Workshop
22nd March 2023
CERN
D. Contardo

Milestone 1, 2028-2029

Strategic programs ALICE-3, LHCb-2, Belle-3, EIC: VD/CT

Highest position precision at lowest power dissipation up to large wafersize

New groups applying for joining Belle II Vertex Upgrade

European Strategy and Belle II (KEK)

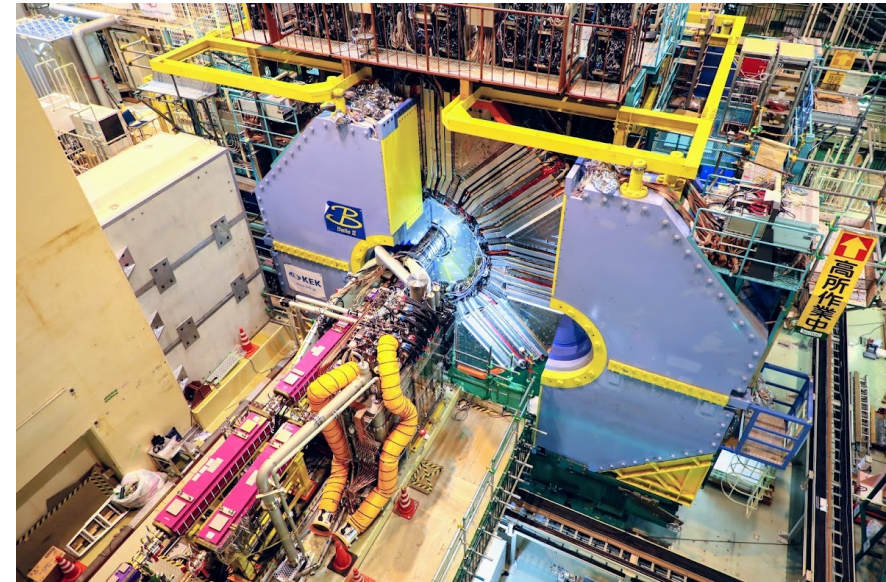
4



Other essential scientific activities for particle physics

A. The quest for dark matter and the exploration of flavour and fundamental symmetries are crucial components of the search for new physics. This search can be done in many ways, for example through precision measurements of flavour physics and electric or magnetic dipole moments, and searches for axions, dark sector candidates and feebly interacting particles. There are many options to address such physics topics including energy-frontier colliders, accelerator and non-accelerator experiments. A diverse programme that is complementary to the energy frontier is an essential part of the European particle physics Strategy. ***Experiments in such diverse areas that offer potential high-impact particle physics programmes at laboratories in Europe should be supported, as well as participation in such experiments in other regions of the world.***

European Strategy recommends participation in flavor experiments outside Europe → Belle II



MEXT Report on SuperKEKB/Belle II

Comprehensive Assessment

The SuperKEKB project is very urgent and strategic, and is highly ranked as a plan that can obtain the consensus of the domestic and international research community and the support of society and the public.

Three scientific goals:

1. Continuation of operation, performance improvement, and data accumulation
 2. Maintenance and *improvement of apparatus*
 3. Experimental data analyses and presentations of scientific outputs
- SuperKEKB/Belle II promoted as a large scale academic frontier project
 - 10 years plan
 - Long term support from hosting lab >2032

Summary

- Belle II physics goals is steering a rich instrumental program
- The detector operates efficiently at peak luminosities just below $10^{35} \text{ cm}^{-2}\text{s}^{-1}$
- LS1 (2023): Detector consolidation for entering $L_{\text{inst}} = 10^{35} \text{ cm}^{-2}\text{s}^{-1}$ regime in the next years
- LS2 (2027): Introducing new technologies for running safely at $6 \times 10^{35} \text{ cm}^{-2}\text{s}^{-1}$ with enhanced performance
→ *Belle II VTX is baseline with CMOS technologies*
- Conceptual Design Report for medium-term detector upgrade → Fall 2023

Essential to participate in DRD3, DRD7 and DRD8 for LS2 (VTX) and beyond (all-silicon tracker)
Belle II VTX: Well structured international community with expertise in large (CMOS) detector systems

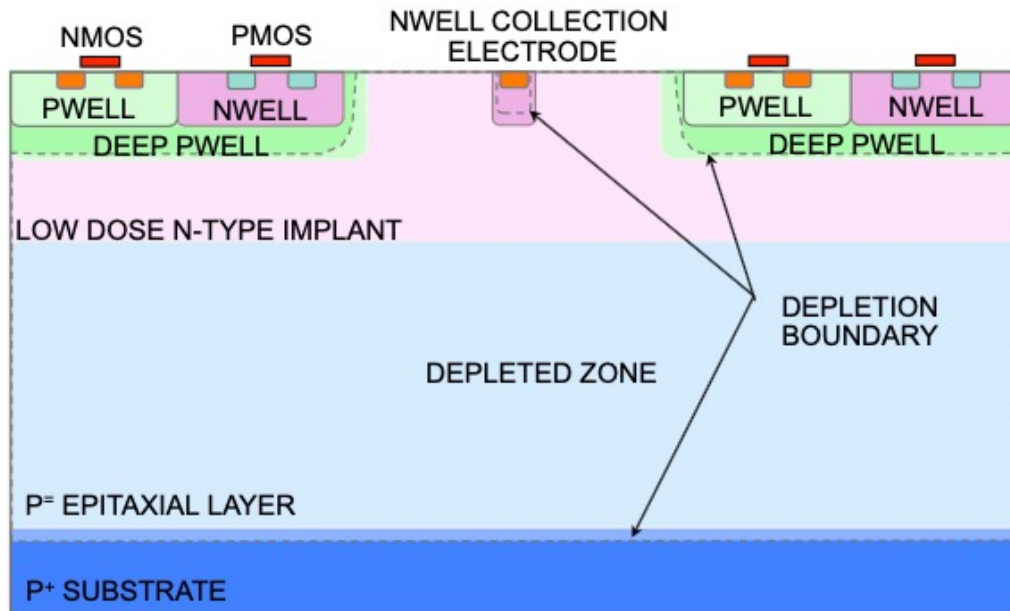
Belle II long-term upgrade aligned with ECFA roadmap, with LS2 as critical intermediate step



THANK YOU

Small Electrode Sensor Design DMAPS

Monolithic detector: Combine sensor and readout on the same wafer



Electronics outside the collection well
Small fill factor

- Very small sensor capacitance
- Low noise and power

TowerJazz 180 nm CIS

- Deep pwell allows for full CMOS in pixel
- High resistivity epi-layer 1-8 kOhm.cm
Epi thickness 18-40 μm
- 3 nm gate oxide for good TID
- Modified process: Additional planar n-type implant
Full depleted volume
Fast charge collection
- Derived from LHC developments

OBELIX: Growing the TJ-Monopix Family

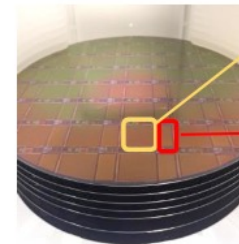
DMAPS in TJ 180 nm: Concept

W. Snoeys et al. <https://doi.org/10.1016/j.nima.2017.07.046>

$C_d \leq 3fF$ $P \approx \frac{S}{N} \approx \frac{Q}{C_d}$

- **Small sensor capacitance (Cd)**
 - Key for low power/low noise
- **Radiation tolerance challenges**
 - Modified process
 - Small pixel size
- **Design challenges**
 - Compact, low power FE
 - Compact, efficient R/O

Large scale demonstrator chip development



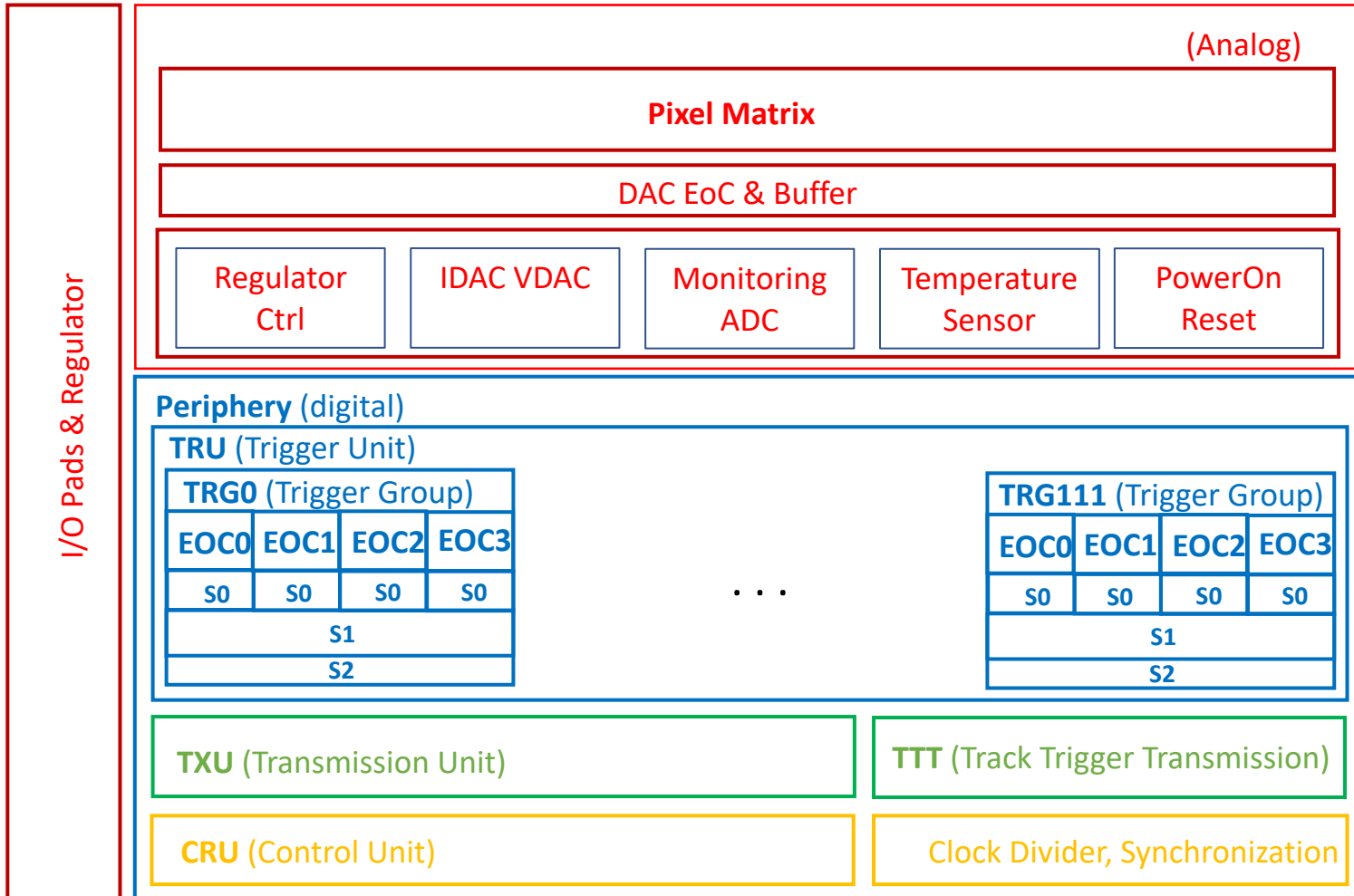
- MALTA
 - Asynchronous readout
 - TJ-Monopix1
 - Synchronous column-drain R/O
- ↓
- Process modification enhancements, Cz substrate ⇒ improved efficiency
- ↓
- TJ-Monopix2: Improved full-scale DMAPS

TJ-Investigator characterization	TJ-Monopix1 & MALTA Design	TJ-Monopix1 & MALTA Submission	Mini-MALTA sub. with process fixes	TJ-Monopix1 resub. process fixes & Cz	TJ-Monopix2 & MALTA2 Design	TJ-Monopix2 & MALTA2 Submission	TJ-Monopix2 Characterization	"OBELIX" Design
Q2 2016	Q4/2016	Q3/2017	Q3/2018	Q2/2019	Q2/2019	Q3/2020	Present	Future plans

Full scale System-ready: LDO, CDR, memory etc.

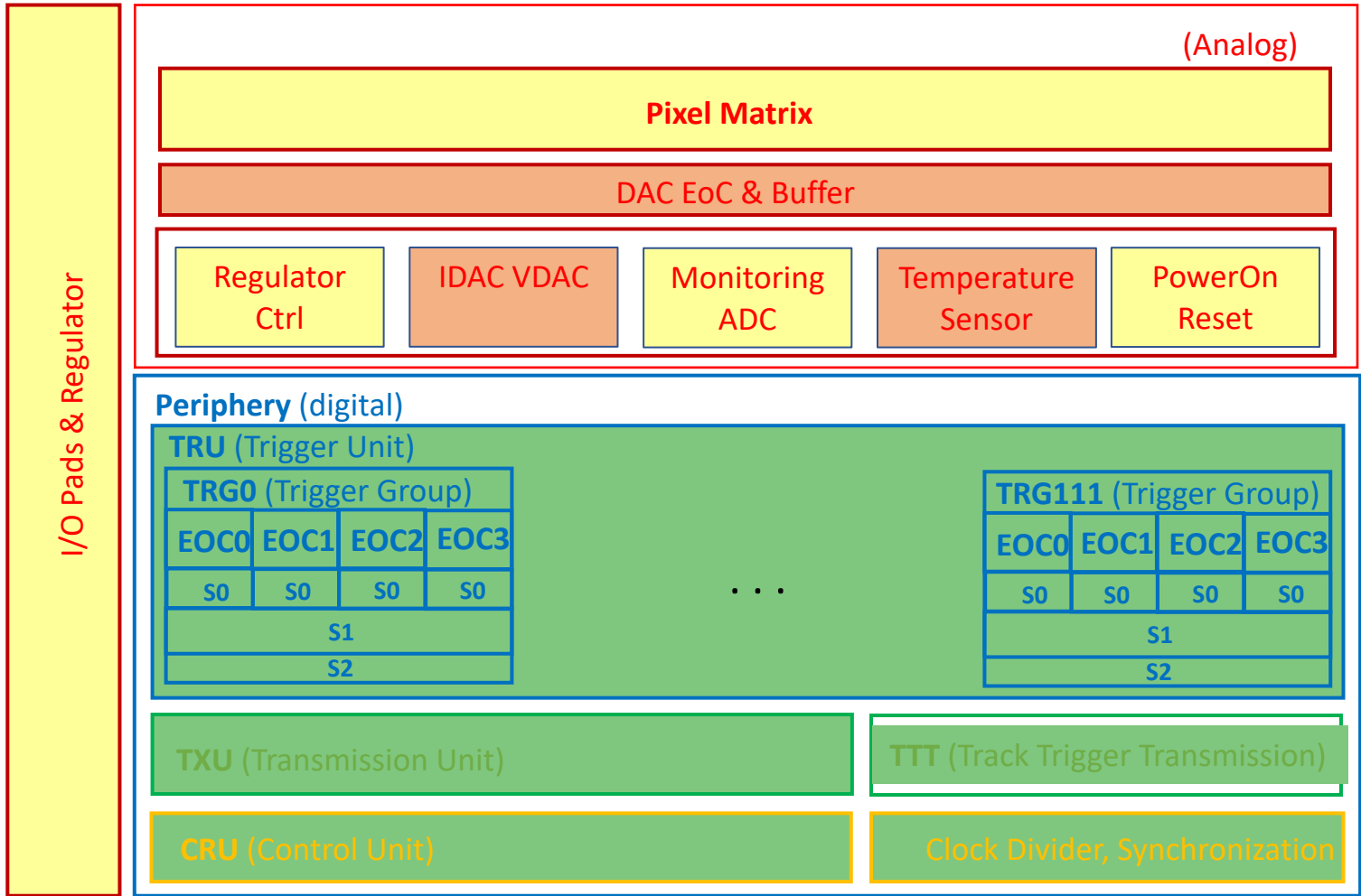


OBELIX – Design



- Pixel matrix
 - Extension from TJ-Monopix2
 - Radiation tolerance granted
 - Pitch kept at 33 μm
 - Operation point (I_{bias}) tuning on-going
 - Frequency $\sim 10\text{-}20$ MHz
 - Time-stamp precision 100 - 50 ns
- Power pads
 - Power regulators
 - Simplified system integration
 - But area limited to <150 μm
- Periphery
 - New end-of-column + trigger logic adapted to Belle II trigger
 - HitOR fast transmission (20 ns)
 - Control using RD53 protocol

OBELIX – Design Status



- Not yet planned
- Not started but planned
- On-going
- Ready, waiting integration



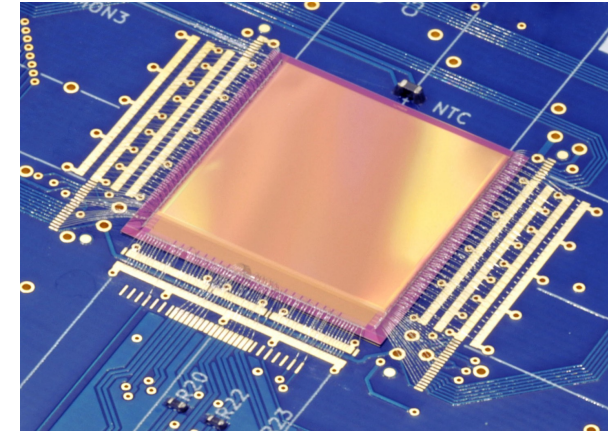
Integration: Summer
Verification: Fall

Contributors (still evolving):

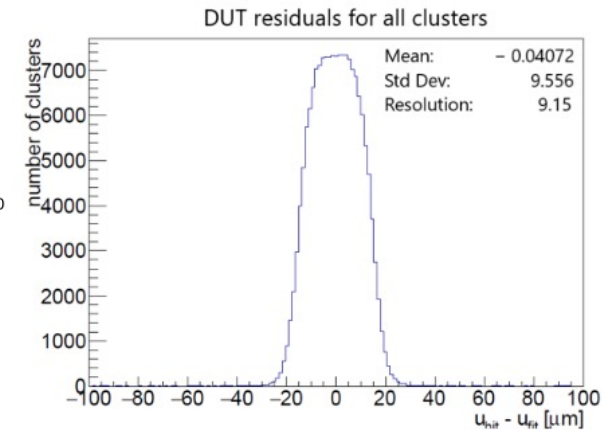
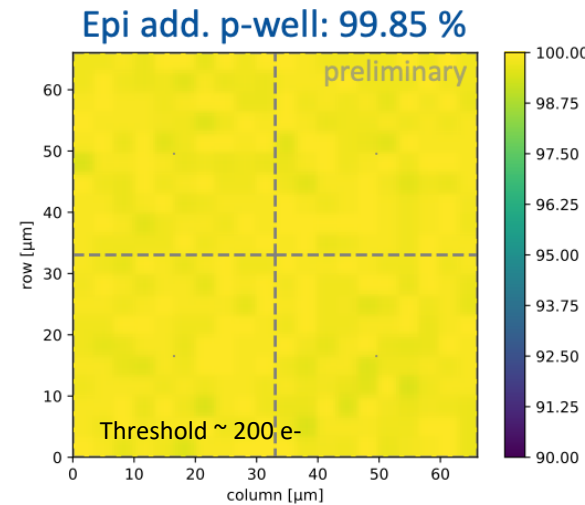
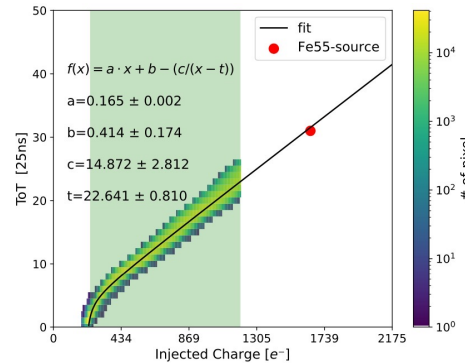
- Matrix: Bonn, IPHC, CPPM, Bergamo/Pavia
- DAC, IDAC, VDAC: IPHC + ?
- Regulator: Dortmund
- Monitoring: IFIC
- TRU: HEPHY
- TXU: HEPHY, CPPM
- CRU: CPPM
- Clock & Synchro: CPPM
- Power On Reset: IPHC

TJ-Monopix2 Characterization

- TJ-Monopix2 as forerunner of OBELIX
 - 33x33 μm^2 pitch, 25 ns integration, 2x2 cm^2 matrix
 - 7 bit ToT information, 3 bit in-pixel threshold tuning
 - Various sensing volume thickness (CZ-bulk, epi-30 μm)

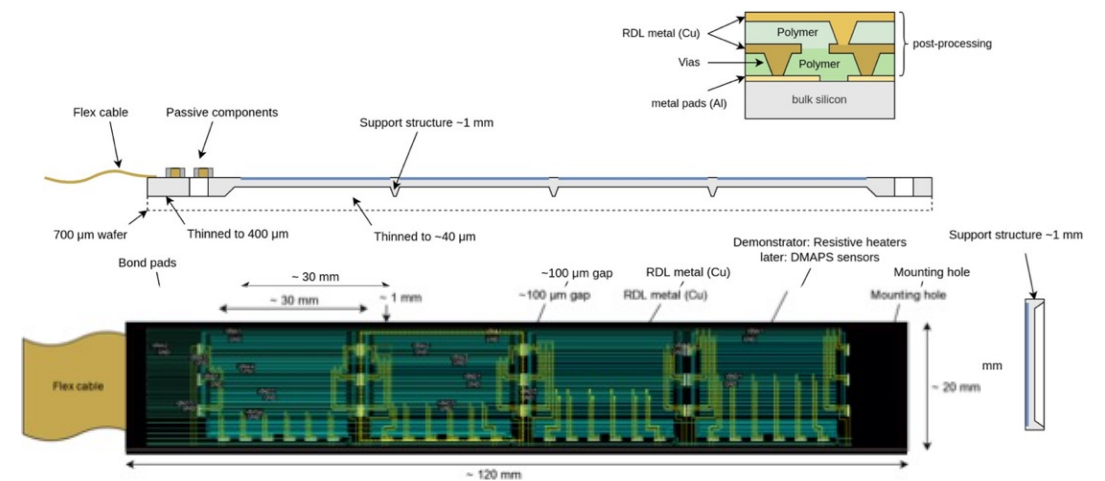


- Characterisation on-going
 - In-laboratory
 - Threshold / noise
 - ToT calibration
 - In-beam (DESY, 5 GeV electrons)
 - Efficiency $\sim 99\%$
 - Position resolution $\sim 9 \mu\text{m}$

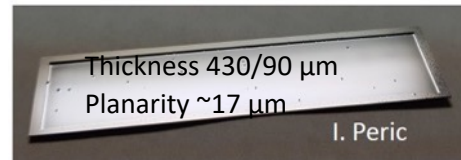


iVTX Inner Layer Concept

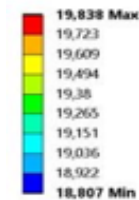
- All-silicon module < 0.15 % X_0
 - 4 contiguous sensors diced as a block from the wafer
 - Redistribution layer for interconnection
 - Heterogeneous thinning for thinness & stiffness
- Prototyping
 - With existing 10 cm² HV-CMOS ladder
 - Planarity demonstration
 - On-going at IZM-Berlin with dummy Si
 - True iVTX geometry → Summer 2023



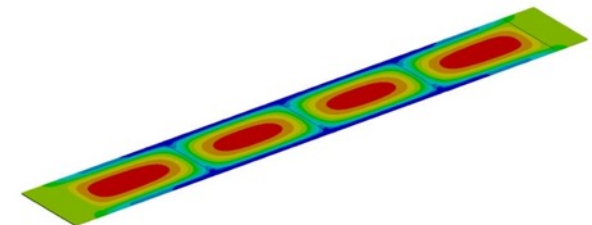
- Simulation on cooling
 - Dry air cooling 15°C
 - Assume 200 mW/cm²



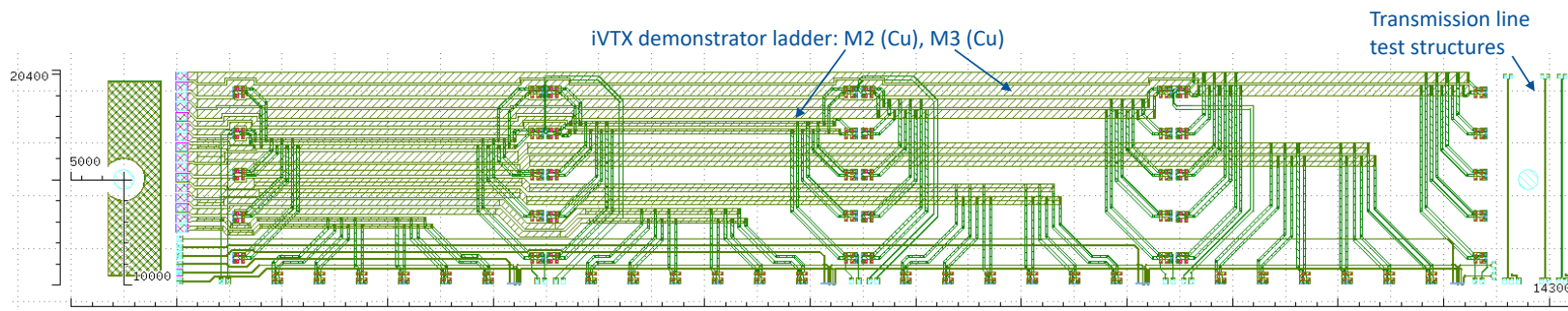
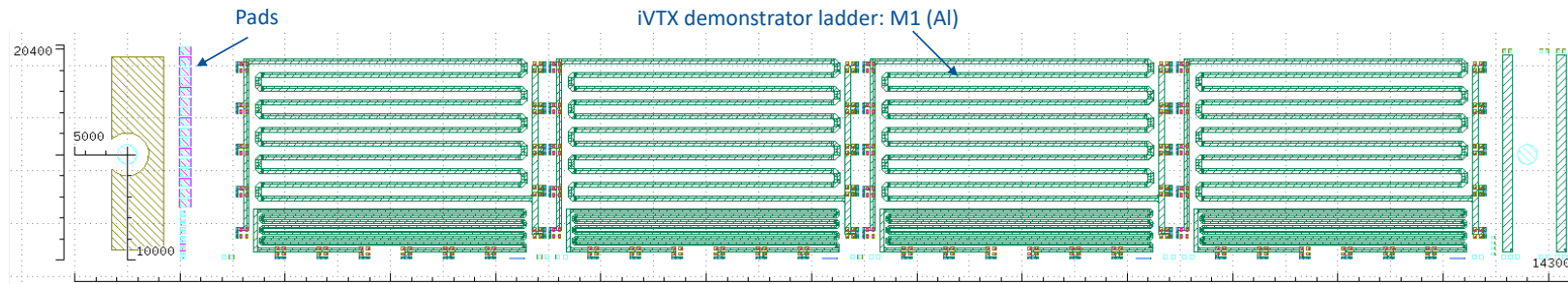
B: Coques
 Température
 Type: Température
 Unité: °C
 Temps: 1 s
 03/06/2022 10:57



$T_{MAX} \sim 20^{\circ}C$
 $\Delta T < 5^{\circ}C$



iVTX Ladder Demonstrator



Metal system:

- Resistive heaters: 1.5 μm Al (M1)
- 2 RDL metal layers: 3 μm Cu (M2, M3)
- Top metal finish: NiAu (M4)

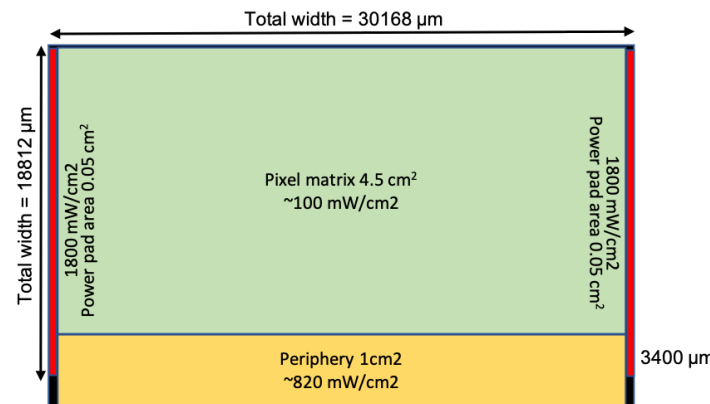
Wirebonding, SMD soldering

Final ladder dimension: 143 x 20.4 mm^2

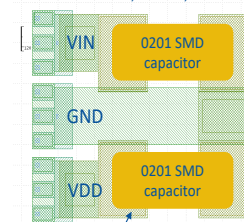
Dummy heaters: 30 x 20 mm^2

Prepared for 1.7 mm mounting hole

Characterization electrical,
mechanical and thermal
performances of iVTX ladders



LDO block: 3x VIN, 3x GND, 3x VOUT

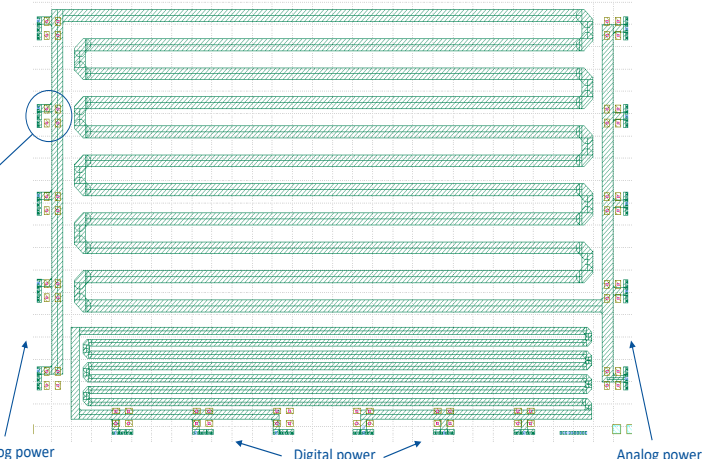


solder pads (M4)

Analog power

Digital power

Analog power



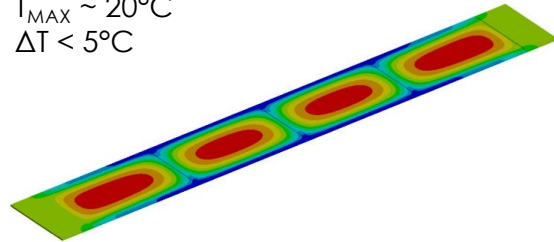
iVTX Cooling

Air cooling (10 m/s, 20 degC) seem feasible, but 9 mm tube seems necessary (3 l/s)

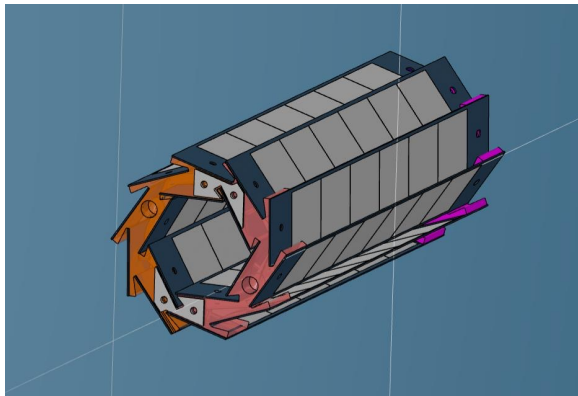
B. Coques
Temperature
Type: Temperature
Unit: °C
Temp: 1 s
03/06/2022 10:57

19.838 Max
19.723
19.609
19.494
19.38
19.265
19.151
19.036
18.922
18.807 Min

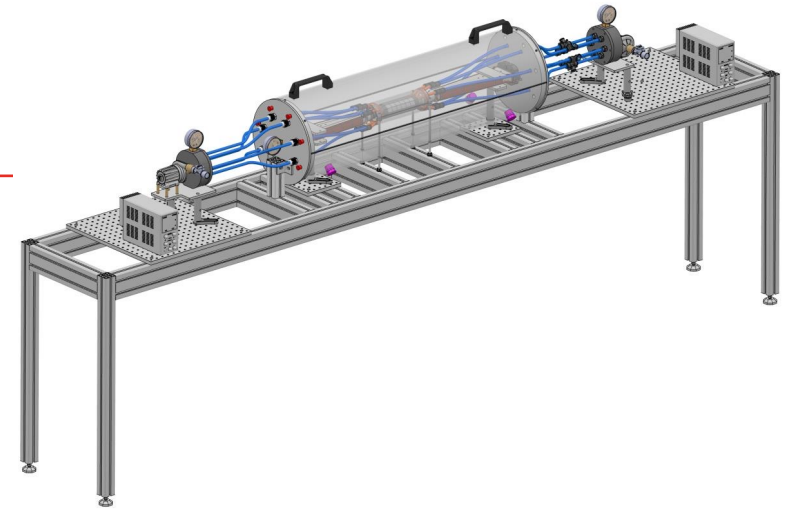
$T_{MAX} \sim 20^{\circ}C$
 $\Delta T < 5^{\circ}C$



0.000 0.018 0.035 0.053 0.070 (m)



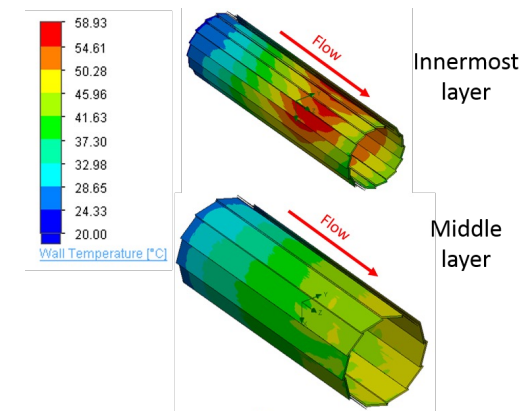
First conceptual air injector support



So far, standing single ladders with uniform power consumption.

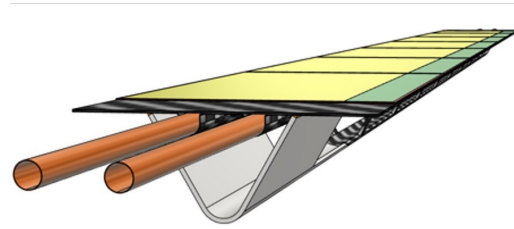
More realism to be added on the FEM...

→ Experience from CLIC wind tunnel:

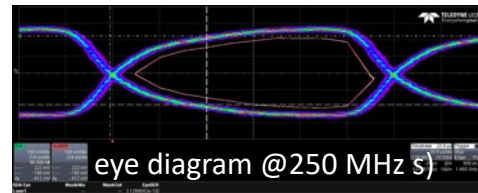


oVTX Outer Layer Concept

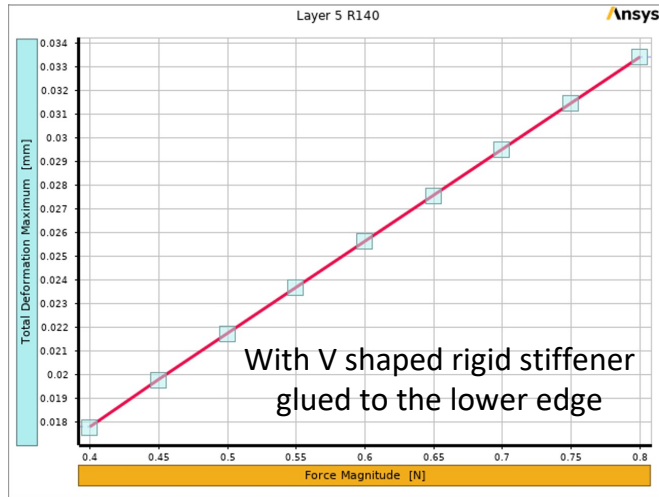
- Long ladders
 - Evolving from ALICE-ITS2
 - Carbon-fiber truss support frame
 - Cold-plate with water coolant
 - Long-flex for power & data
- Prototypes for L5 under test
 - Deformation & vibration
 - Max sagitta $\sim 500 \mu\text{m}$
 - First resonance $f=250 \text{ Hz}$
 - Signal propagation
 - Cooling at $T_{\text{room}} \sim 24^\circ\text{C}$
 - Leakless water flow at $T_{\text{in}} = 10^\circ\text{C}$
 - Heaters dissipating 200 mW/cm^2
 - $22^\circ\text{C} < T_{\text{sensors}} < 26^\circ\text{C}$



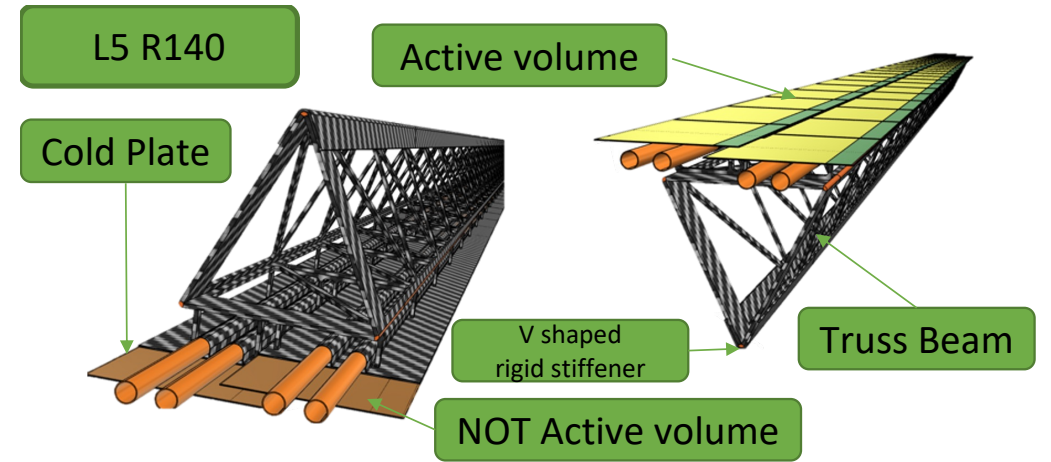
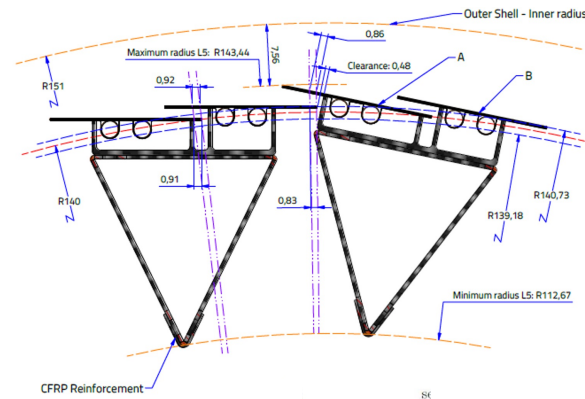
- L3-4, radius 4-9 cm, length $< 50 \text{ cm}$
 - Single sensor row, $\sim 0.5 \% X_0$
- L5, radius 14 cm, length 70 cm
 - Double sensor rows, $\sim 0.8 \% X_0$



oVTX Stave Integration



Realistic CAD model, including overlap studies



Studying mechanical properties with realistic models:
Tolerable max. deflection of the structure (40 μm)

Ladder concept compatible with X/X_0 expectations (0.4-0.8%)

Layer 3 R69 Radiation length summary
2 flex from FW and BW side (6 + 6 chips) - 12 chips

COMPONENT	X/X_0 (%)
Support Structure	0,087%
Cold Plate	0,064%
Pipes & Coolant	0,048%
Glue	0,022%
Flex (FW + BW)	0,150%
Chips	0,066%
Grand Total	0,438%

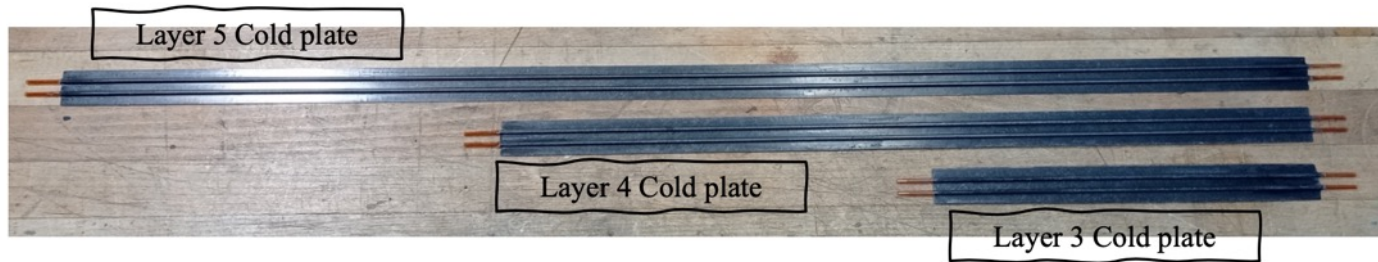
Layer 4 R89 Radiation length summary
2 flex FW and BW side (8 + 8 chips) - 16 chips

COMPONENT	X/X_0 (%)
Support Structure	0,086%
Cold Plate	0,069%
Pipes & Coolant	0,048%
Glue	0,021%
Flex FW + BW	0,161%
Chips	0,067%
Grand Total	0,454%

Layer 5 R140 Radiation length summary
2 flex FW and BW side (12 + 12 chips) - 24 chips

COMPONENT	X/X_0 (%)
Support Structure	0,169%
Cold Plate	0,093%
Pipes & Coolant	0,153%
Glue	0,127%
Flex FW + BW	0,186%
Chips	0,069%
Grand Total	0,796%

oVTX Stave Demonstrator



Completing a fully equipped L5 ladder (mechanical structure + cold plate + flex)
Assembly procedure well defined

